# **Modules**











# **Product Technical Specification**

EM919x/EM7690

41113174 Rev 9 Proprietary and Confidential Contents subject to change

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Preface

## Sierra Wireless

Semtech Corporation purchased Sierra Wireless in January 2023. The Sierra Wireless brand is gradually being phased out. During the phase-out period, references to both "Semtech" and "Sierra Wireless" may appear in product documentation.

#### **Contact Information**

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|---|--|
| Corporate and product information                                       | Web: sierrawireless.com  |

# **Revision History**

| Revision<br>number | Release<br>date  | Changes  |  |
|--------------------|--|--|--|
| 0.1-Draft          | Oct 2019   | Preliminary release  |  |
| 0.2-Draft          | Nov2019  | Updated pinouts, RF and connectors, mechanical drawings, and thermal notes, some power consumptions changed to TBD   |  |
| 0.3-Draft          | Nov 2019   | Cleaned up a few pinout descriptions, updated module control signals, added notes for optional signals, removed band of n8, updated 5G UL modulation, added preliminary CA and EN-DC tables  Updated M.2 pinout to have both USB3.1 and PCIe signals, added PCIE_DIS for interface selection, updated M.2 port configuration, added 3 VCC pins, added ANT_CTRLx pins, changed to use MHF7S connectors, added figures of USB3, specified maximum sink current for WWAN_LED#, updated supported NR bands and bandwidth in 4.6, updated typical conducted Rx sensitivities in 4.7, updated 5G NR data rates, updated MIMO support descriptions, added notes for CA/EN-DC, updated power state transition trigger levels, removed GNSS features of 10Hz and SBAS, added production testing with reference document.  Corrected some data rates in Table 1-1, updated system block diagram, added VCC peak and continuous current spec, updated RESET# timing, updated PCIe/USB descriptions and power on/off timing diagrams and parameters, updated mmWave IF ports assignment, updated GNSS specifications, updated power consumption data, updated MHF7S part numbers, added mmWave guidelines reference document, removed intra-band EN-DC on n41. |  |
| 0.4-Draft          | Mar 2020   |  |  |
| 0.5-Draft          | May 2020   |  |  |
| 0.6-Draft          | Changed to EM919X/EM7690 to include EM9190, EM9191 and EM7690. power consumption, updated RESET timing, added ESDC compliance, up sensitivity, updated DPR of SAR backoff control, updated mechanical draw weight information, updated antenna gain and collocated radio transmitter specifications, updated FCC ID and IC, added FCC compliance standards |  |  |

| Revision<br>number  | Release<br>date | Changes  |  |
|---|-----------------|--|--|
| 0.7-Draft   | Jul 2020        | Added variants information, specified EM9191 data rate, added bands n7, n8, n12, n20, n25, n38, n40, n48 and B43 support in future release, clarified RF power class and B41 standalone HPUE, updated bandwidth support for some bands, updated some NR conducted Rx sensitivity, added some notes for PCIe interface, added non-sleep mode standby power consumption, updated mechanical and environmental specifications, updated mechanical drawings, updated CA and EN-DC tables, added a few reference documents. |  |
| DL MIMO, added 42C for Intra-band ULCA, updated B71 bandwidth sometimes of the section 3.7, updated Properties of the section 3.7, updated power supply/consumption spec for EM9190, EI |                 | Updated EM9191 variant information, updated EM9191 DL throughput, updated n41 DL MIMO, added 42C for Intra-band ULCA, updated B71 bandwidth support, added a note for B46 Conducted Rx Sensitivity, updated Tx Power Control and moved to section 3.7, updated power supply/consumption spec for EM9190, EM9191 and EM7690 respectively, updated CA and EN-DC tables based on updated EM9191 capability, updated a few reference documents.  |  |
| 1   | Oct 2020        | Removed USB2.0 backward-compatible references Updated resistor value - Figure 3-7 Recommended Wireless Disable Connection Updated 3.6.6 PCIE_DIS - Interface Selection Updated Table 5-1 Averaged Standby DC Power Consumption Added test data footnote - Table 5-2 Averaged Call Mode DC Power Consumption Added footnote - Table 5-5 Power State Transition Trigger Levels Updated PLA_S2# signal details - Figure 5-2 Power On/Off Timing for PCIe Port, ar Table 5-6 PCIe Timing                                   |  |
| 2   | Nov 2020        | Updated Table 5-1 Averaged Standby DC Power Consumption Updated Figure 7-5 Unit Product Marking Example  |  |

| Revision number | Release<br>date | Changes   |  |
|-----------------|-----------------|---|--|
| 3               | Jul 2021        | B42/B48 enabled Updated Table 1-1, Module Variants, on page 14 Updated Table 1-2, RF Band Support, on page 15 Updated Table 1-3, Required Host-Module Connectors, on page 20 Updated Host Interface Features on page 17 Updated Modem Features on page 17 Updated SG Features on page 18 Updated LTE Features on page 18 Updated USB Interface on page 30 (USB 2.0 operation note) Updated Table 3-1, Host Interface (75-pin) Connections—Module View, on page 25 (removed Coexistence) Updated Table 3-2, Power Supply Requirements, on page 30 (removed VCC footnote) Updated Table 3-2, Power Supply Requirements, on page 30 (removed VCC footnote) Updated Table 4-1, Antenna Connectors—RF Technology Support, on page 43 Updated RF Connections on page 45 (mmWave connector part number) Updated Table 4-4, Supported Frequency Bands, by RAT (5G/LTE/3G), on page 49 Updated Table 4-6, EM919x NR Bandwidth and 5G Architecture Support, on page 52 Updated Table 4-9, Typical Conducted Rx Sensitivity—NR Bands, on page 54 Updated Table 4-9, Typical Conducted Rx (Receive) Sensitivity—LTE Bands at 10 MHz BW, on page 55 Updated Table 4-12, Conducted Maximum Tx (Transmit) Power Tolerances, on page 57 Updated Table 5-2, Averaged Call Mode DC Power Consumption, on page 60 Updated Power On/Off Timing for PCIe Port on page 64 Updated Table 5-6, PCIe Timing, on page 65 Updated Required Shutdown Sequence on page 66 Updated Required Shutdown Sequence on page 66 Updated Table 8-1, Antenna Gain and Collocated Radio Transmitter Specifications, on page 79 Updated Table A-3, Low Power/High Power mmWave Antenna Comparison, on page 84 Updated Table B-1, Hardware Integration Design Considerations, on page 89 (removed Host/Modem Communication) |  |
| 4               | Oct 2021        | Updated Table 1-1—consolidated content Updated Table 1-2—consolidated content Renamed Supported Frequencies section to Supported RATs, added subsection headings Updated Table 4-9—corrected n40 worst case sensitivity requirement Updated Table 4-12—corrected typo (replaced LTE B38 with LTE B3), added single-cell detail for same row Updated Table 8-1—removed LTE B38 Updated Table 8-1—removed LTE B38 Updated reference doc number and availability—[15] EM9 Carrier Aggregations and EN-DC (Doc# 2174317) Updated Table A-1—added max input power at antenna ports   |  |

| Revision<br>number  | Release<br>date | Changes   |  |
|---|-----------------|---|--|
| Renamed section 3.9 mmWave Antenna Power Control Added 3.10 Antenna Control Updated Table 4-6—supported architectures Updated 4.6 Supported RATs—removed 48C from LTE Advanced carr list  |                 | Added 3.10 Antenna Control Updated Table 4-6—supported architectures Updated 4.6 Supported RATs—removed 48C from LTE Advanced carrier aggregation list Updated Table 4-12—updated 5G section; updated LTE band groups; removed single-  |  |
| Updated Table 1-2 (Removed incorrect FR1 UL MIMO entry; added link to 0 support; updated 5G NR FR1 content)  Marked ANT_CTRL1-3 as reserved (Table 3-1; Antenna Control)  Added Table 4-1 (5G NR band support by QTM type)  Removed 4.5.1 Sierra Wireless' Sensitivity Testing and Desensitization Invelopment Updated Table 4-9 (worst case n8/n12/n20/n25)  Updated 5.3.2.4 Required Shutdown Sequence—power off timing note Updated Figure 7-7 (added debugging test points)  Updated 7.4 Thermal Considerations (added debugging test points)   |                 | Marked ANT_CTRL1-3 as reserved (Table 3-1; Antenna Control) Added Table 4-1 (5G NR band support by QTM type) Removed 4.5.1 Sierra Wireless' Sensitivity Testing and Desensitization Investigation Updated Table 4-9 (worst case n8/n12/n20/n25) Updated 5.3.2.4 Required Shutdown Sequence—power off timing note Updated Figure 7-7 (added debugging test points)   |  |
| 7   | Nov 2022        | ephrased MIMO support in 5G Features and LTE Features pdated Table 3-2 (EM7690 Continuous current) eorganized 4 RF Specifications pdated Table A-1, Table A-2 (antenna name references)   |  |
| 8   | May 2023        | Updated Table 3-1 footnote on pins 24/38/68 to apply only to EM7690 Updated Table 4-1 (Reformat; clarified B32) Updated Table 4-11 (Band 1,2,4,5,8,19 sensitivity values) Updated Table 5-1 (Removed footnote from Standby and LPM sections; updated current for LPM with Host interface suspended) Updated 5.3.2.4 Required Shutdown Sequence—reverted power off timing note   |  |
| Added WCDMA Features Updated Table 1-2 (updated WCDMA and UMTS standards) Updated Mechanical Features and Table 6-1 (noted effect on operating temper external SIM, and added eSIM operating temperature note) Removed chapter 2: Standards (subsequent chapters renumbered) Updated Figure 2-1 (System Block Diagram) Updated W_DISABLE# (WWAN Disable) and GPS_DISABLE# (GNSS Disable) to Dying Gasp feature Updated Table 3-10 (B43, B48 worst case sensitivity) Updated Power State Transitions (Table 4-5, Figure 4-1) Updated drawings for shifted MHF4 connector (Figure 6-1, Figure 6-2, Figure 6-4) Updated Regulatory Compliance and Industry Certifications (removed FAC, CCC Standards) Updated Table 7-1 (B43, B48, n48) |                 | Updated Table 1-2 (updated WCDMA and UMTS standards)  Updated Mechanical Features and Table 6-1 (noted effect on operating temperature for external SIM, and added eSIM operating temperature note)  Removed chapter 2: Standards (subsequent chapters renumbered)  Updated Figure 2-1 (System Block Diagram)  Updated W_DISABLE# (WWAN Disable) and GPS_DISABLE# (GNSS Disable) to include Dying Gasp feature  Updated Table 3-10 (B43, B48 worst case sensitivity)  Updated Power State Transitions (Table 4-5, Figure 4-1)  Updated drawings for shifted MHF4 connector (Figure 6-1, Figure 6-2, Figure 6-3, Figure 6-4)  Updated Regulatory Compliance and Industry Certifications (removed FAC, CCC, KCC; added Standards) |  |

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#### 1: Introduction

The Sierra Wireless EM91 Embedded Module series (EM9190, EM9191, EM7690) are FirstNet-ready (B14 LTE) M.2 modules that provide 5G NR Sub-6G, 5G NR mmWave, 4G LTE advanced Pro, 3G (HSPA+, UMTS) and GNSS connectivity for a wide range of devices and purposes including business, personal, portable computing and communication devices, IoT devices, M2M applications and industrial use cases.

Note: In this document:

- EM91 refers to the EM91 module series, which includes EM9190, EM9191, and EM7690.
- EM919x refers to EM9190 and EM9191.

EM91 modules are available in region-specific and function-specific variants. Table 1-1 indicates RF capabilities supported by each variant.

Table 1-1: Module Variants

| Variant | LTE Only  | LTE+FR1 NSA EN-DC/FR1 SA | LTE+FR2 NSA EN-DC |
|---------|-----------|--------------------------|-------------------|
| EM9190  | Supported | Supported                | Supported         |
| EM9191  | Supported | Supported                | Not supported     |
| EM7690  | Supported | Not supported            | Not supported     |

Note: Sierra Wireless modules are shipped factory-programmed with industry or mobile operator approved firmware, according to the specific SKU ordered. Periodically, newer firmware versions become available and can include new features, bug fixes, or critical security updates. Sierra Wireless strongly recommends that customers establish their own production capability for updating module firmware on their assembled end platform, in the event that a newer firmware must be installed before deployment. Sierra Wireless also recommends customers design their products to support post-deployment FOTA upgrades using the AirVantage cloud platform.

#### 1.1 Supported RF bands

The modem supports data operation on 5G NR, 4G LTE and 3G networks over the bands described in Table 1-2. For additional RF details, see Supported RATs on page 46.

Table 1-2: RF Band Support

| RAT        | Bands   | Capabilities <sup>a</sup>   |
|------------|---|---|
|            | FR2 (mmWave) <sup>b</sup> n257, n258, n260, n261 (For antenna module-specific band support, see Table 3-2 on page 42.)  | Downlink (DL):  LTE 7CC (20 layers max) + 5G NR FR2 4CC (400 MHz BW max)  LTE 7CC (8 layers max) + 5G NR FR2 8CC (800 MHz BW max)  64QAM, 2x2 MIMO  Uplink (UL):  LTE 1CC + 5G NR FR2 2CC (200 MHz BW max)  64QAM, 2x2 MIMO   |
|            |   | NSA (ENDC)  |
| 5G NR      | FR1 (sub-6GHz) <sup>c</sup><br>n1 <sup>d</sup> , n2 <sup>d</sup> , n3 <sup>d</sup> , n5, n7 <sup>e</sup> , n8 <sup>e</sup> , n12 <sup>e</sup> ,<br>n20 <sup>e</sup> , n25 <sup>e</sup> , n28 <sup>d</sup> , | EM9190 Downlink (DL):  LTE 7CC (20 layers max) + 5G NR FR1 TDD 1CC (100 MHz BW max)  LTE 4CC (8 layers max) + 5G NR FR1 TDD 2CC (200 MHz BW max)  LTE 7CC (20 layers max) + 5G NR FR1 FDD 1CC (40 MHz BW max)  256QAM, 4x4 or 2x2 MIMO  EM9191 Downlink (DL):  LTE 7CC (12 layers max) + 5G NR FR1 TDD 1CC (100 MHz BW max)  LTE 7CC (16 layers max) + 5G NR FR1 FDD 1CC (40 MHz BW max)  256QAM, 4x4 or 2x2 MIMO  Uplink (UL):  LTE 1CC + 5G NR FR1 TDD 1CC (100 MHz BW max)  LTE 1CC + 5G NR FR1 FDD 1CC (40 MHz BW max)  256QAM, SISO    |
|            | n38 <sup>e</sup> ,<br>n40 <sup>e</sup> , n41 <sup>d</sup> , n48 <sup>e</sup> ,<br>n66 <sup>d</sup> ,  | SA  |
|            | n71 <sup>d</sup> , n77 <sup>d</sup> , n78, n79  | <ul> <li>Downlink:</li> <li>5G NR FR1 TDD 2CC (up to 200 MHz aggregate BW max) (Note: Older firmware releases limited to 5G NR FR1 TDD 1CC (100 MHz BW max))</li> <li>5G NR FR1 FDD 1CC (40 MHz BW max) (Note: Older firmware releases limited to 5G NR FR1 FDD 1CC (20 MHz BW max))</li> <li>256QAM, 4x4 or 2x2 MIMO</li> <li>Uplink:</li> <li>5G NR FR1 TDD 1CC (100 MHz BW max)</li> <li>5G NR FR1 FDD 1CC (40 MHz BW max) (Note: Older firmware releases limited to 5G NR FR1 FDD 1CC (20 MHz BW max))</li> <li>256QAM, SISO</li> </ul> |
| LTE        | LTE B1, B2, B3, B4, B5, B7, B8, B12, B13, B14, B17, B18, B19, B20, B25, B26, B28, B29, B30, B32, B34, B38, B39, B40, B41, B42, B43 <sup>e</sup> , B46 <sup>g</sup> , B48, B66, B71                          | <ul> <li>DL Cat 20:         <ul> <li>7CC (20 layers max)</li> <li>256QAM, 4x4 or 2x2 MIMO</li> </ul> </li> <li>UL Cat 18:         <ul> <li>2CC (2 layers max) intra-band contiguous and inter-band</li> <li>256QAM, SISO</li> </ul> </li> <li>Supported CC BW up to 20 MHz, per 3GPP specs for supported bands</li> </ul>   |
| 3 <b>G</b> | HSPA+/WCDMA/UMTS<br>Bands 1, 2, 4, 5, 6, 8, 9, 19   | <ul> <li>DC-HSPA+ — Rel 10</li> <li>WCDMA — Rel 9</li> <li>UMTS — Rel 9</li> </ul>  |

Table 1-2: RF Band Support (Continued)

| RAT  | Bands  | Capabilities <sup>a</sup>    |
|------|--|------------------------------|
| GNSS | L1<br>GPS/QZSS L1, GLONASS G1, Galileo E1,<br>BeiDou B1i | Standalone and assisted GNSS |
|      | L5h<br>GPS L5, GAL E5a, QSZZ L5, BDS B2a                 |                              |

- a. For theoretical peak data rate with minimal overhead and maximal TDD ratio, refer to [7] EM919X 5G NR Peak Throughput (Doc# 2174277).
- b. EM9190 only. The EM9190 supports 5G NR mmWave only when used in combination with optional Qualcomm mmWave antenna hardware—the QTM525 low power and QTM527 high power mmWave antenna modules include their own active antenna arrays, dedicated power management, integrated frequency up-converters, and power amplifiers.

  Note that mmWave is supported only in NSA mode.
- c. EM919x only, not supported in EM7690
- d. Band is supported in NSA mode. Band support in SA mode is firmware and SKU dependent.
- e. Band support is firmware and SKU dependent.
- f. To assist OEMs to meet FCC and PTCRB rules, LTE band 30 is set to downlink only by default.
- g. LTE-LAA B46 (downlink only)
- h. The L1 signal is required for decoding the L5 signal.

#### 1.2 Mechanical Features

- M.2 form factor:
  - WWAN Type 3042–S3–B (in WWAN PCIe and USB3 Port Configuration 2) with length of 52 mm, as specified in [20] PCI Express M.2™ Specification Revision 3.0, Version 1.2.
  - · Conforms to M.2 form factor width specification. For complete dimensions, see Figure 6-2.
  - · Input voltage per M.2 specification

Note: Any variations from the M.2 specification are detailed in this document.

- Ambient operating temperature range with appropriate heatsinking, when using a suitable external SIM:
  - · Class A (3GPP compliant): -30°C to +70°C
  - · Class B (operational, non-3GPP compliant): -40°C to +85°C (reduced operating parameters required)

Note: The optional onboard eSIM is operational between component temperatures of -25 °C to +85 °C.

**Important:** The internal module temperature (reported by AT!PCTEMP?) must be kept below 115°C. For best performance, the internal module temperature should be kept below 100°C. Proper mounting, heat sinks, and active cooling may be required—refer to [3] EM9190 Thermal Application Note (Doc# 2174257) for details. Refer also to [4] EM919x/EM7690 Thermal Mitigation Application Note (Doc# 2174267).

#### 1.3 Host Interface Features

EM91 modules support PCIe and USB physical host interfaces, with the following features:

- Operating system support:
  - · Windows, Linux, Android
  - · Mobile Broadband packages for each system (MBPW, MBPL, MBPA)
  - · SDK with rich set of APIs and sample applications
- PCIe.
  - Gen 3, Single lane

- Typical PCIe topology:
  - · Module configured as a PCIe End Point (EP)
  - · Host is the PCIe root complex (RC) node
- USB:
  - USB3.1
  - · Configurable USB composite interface Enable / disable specific interfaces via AT command
- AT command interface and proprietary extended AT commands. For details, refer to [1] Sierra Wireless EM9 Series AT Command Reference (Doc# 41113480).

For additional details, refer to [13] Software Integration and Development Guide for Linux USB Platforms (Doc# 41114212) and [14] Software Integration and Development Guide for Linux Platforms (Doc# 41113764).

#### 1.4 Modem Features

- 5G NR mmWave (EM9190), 5G NR Sub-6G (EM919x), 4G LTE, 3G (DC-HSPA+/HSPA+/HSPA/WCDMA) operation
- Multiple (up to 16) cellular packet data profiles
- Traditional modem COM port support for AT commands
- Host interface (USB, PCIe) support for USB Selective Suspend (USB SS) and PCIe power management to minimize idle power draw
- OoS OC
- Static and Dynamic IP address. The network may assign a fixed IP address or dynamically assign one using DHCP (Dynamic Host Configuration Protocol).
- PDP context type (IPv4, IPv6, or IPv4v6)
- RFC1144 TCP/IP header compression
- Public Safety 3GPP Features 3GPP R15 (per 3GPP TS 23.203, TS 29.212): QCI values 65, 66, 69, and 70

#### 1.5 5G Features

Note: 5G features are supported on EM919x only, and mmWave features are supported on EM9190 only.

- Supported frequency range: FR1 (Sub-6G) and FR2 (mmWave)
- Network options:
  - · SA (Option 2):
    - TDD: n38<sup>1</sup>, n40<sup>1</sup>, n41, n48<sup>1</sup>, n77, n78, n79
    - FDD: n1, n2, n3, n5, n7<sup>1</sup>, n8<sup>1</sup>, n12<sup>1</sup>, n20<sup>1</sup>, n25<sup>1</sup>, n28, n66, n71
  - NSA (Options 3a/3x)
    - · Supports EN-DC for all NR bands See CA/EN-DC Support.
- Modulation:
  - · UL modulation: FR1 (256QAM), FR2 (64QAM)
  - · DL modulation: FR1 (256QAM), FR2 (64QAM)

<sup>1.</sup> Band support is firmware and SKU dependent.

#### 5G MIMO support:

|      | Uplink       | (UL)      | Downlink (DL)  |           |  |  |  |
|------|--------------|-----------|--|-----------|--|--|--|
| мімо | FR1 (Sub-6G) | FR2 (mmW) | FR1 (Sub-6G)   | FR2 (mmW) |  |  |  |
| 2x2  | n/a          | Yes       | Supported on all bands  Band n41 uses MIMO1 and MIMO2 antennas.  All other bands use MAIN (PRx) and AUX (DRx) antennas.          | Yes       |  |  |  |
| 4x4  | n/a          | n/a       | Supported on bands:<br>n1/2/3/7 <sup>a</sup> /25 <sup>a</sup> /38 <sup>a</sup> /40 <sup>a</sup> /41/48 <sup>a</sup> /66/77/78/79 | n/a       |  |  |  |

- a. Band support is firmware and SKU dependent
- SCS:
  - FR1: FDD (15 KHz); TDD (30 KHz)
  - FR2: Data and sync channels (120 KHz); Sync channels only (240 KHz)
- BW per CC:
  - FR1: Up to 100 MHzFR2: 50 MHz, 100 MHz
- 1.6 LTE Features
- Carrier aggregation:
  - DL: Up to 7CC
  - · UL: 2CC intra-band continuous and inter-band CA
- LTE MIMO support:

| МІМО | Uplink (UL) | Downlink (DL)   |
|------|-------------|---|
| 2x2  | n/a         | Supported on all bands. All bands use MAIN (PRx) and AUX (DRx) antennas.            |
| 4x4  | n/a         | Supported on bands:<br>B1/2/3/4/7/25/30/32/34/38/39/40/41/42/43 <sup>a</sup> /48/66 |

- a. Band support is firmware and SKU dependent
- HPUE: B41
- LAA: supported by B46
- Modulation:
  - · DL modulation: Up to 256QAM
  - UL modulation: Up to 256QAM
- CSG support (LTE Femto)
- LTE Advanced receivers (NLIC, elCIC, felCIC)
- Basic cell selection and system acquisition
  - · PSS/SSS/MIB decode
  - · SIB1-SIB16 decoding
- NAS/AS security procedures
  - Snow 3G/AES/ZUC security

- CQI/RI/PMI reporting
- Paging procedures
  - · Paging in Idle and Connected mode
- Dedicated bearer
  - Network-initiated dedicated bearer
  - · UE-initiated dedicated bearer
- Multiple PDN connections (IPv4 and IPv6 combinations), subject to operating system support.
- Connected mode intra-LTE mobility
- Idle mode intra-LTE mobility
- iRAT between LTE/3G for idle and connection release with redirection
- Detach procedure
  - · Network-initiated detach with reattach required
  - · Network-initiated detach followed by connection release

#### 1.7 WCDMA Features

- Network Assisted Fast Dormancy Release 8
- SRB over HSDPA
- F-DPCH
- CPC
- E-FACH
- HS-FACH
- HS-RACH
- Multi-RAB:
  - · Interactive PS
  - Interactive PS/CS
- Discontinuous Transmission (DTX)

#### 1.8 Short Message Service (SMS) Features

- Mobile-originated and mobile-terminated SMS over IMS
- Mobile-originated and mobile-terminated SMS over SGs

#### 1.9 Position Location (GNSS)

- High-precision GNSS with L1+L5 (optional)
- Customizable tracking session
- Automatic tracking session on startup
- Concurrent standalone GNSS (GPS, GLONASS, Galileo, BeiDou, QZSS)
- Simultaneous fixes from two GNSS systems (e.g. GPS and GLONASS)
- Assisted GPS (A-GPS)/GLONASS SUPL2.0 with configurable aiding refresh rate
- gpsOneXTRA 2.0/3.1

#### 1.10 Accessories

A hardware development kit (part #6001349) is available for Sierra Wireless M.2 modules. The kit contains hardware components for evaluating and developing with the module, including:

- Development board
- Cables
- Antennas
- Other accessories

For details, refer to [2] Sierra Wireless EM919x/EM7690 Development Kit User Guide (Doc# 41113875).

#### 1.11 Required Connectors

Table 1-3 describes the connectors used to integrate the EM91 Embedded Module into your host device.

Table 1-3: Required Host-Module Connectors<sup>a</sup>

| Connector type                                | Description  |
|---|--|
| RF cables —<br>5G NR Sub-6G/LTE/GNSS          | <ul> <li>Mate with M.2-spec connectors</li> <li>Four connector jacks (mate with I-PEX 20448-001R-081 or equivalent)</li> </ul>   |
| RF cables — 5G NR mmWave <sup>b</sup>         | <ul> <li>Eight connector jacks (mate with I-PEX 20955-001R-13 or equivalent)</li> <li>Two cables for each mmWave antenna module (up to 8 cables in total)</li> </ul>   |
| M.2 (Slot B-compatible) 67-pin edge connector | <ul> <li>Slot B compatible — Per the M.2 standard ([20] PCI Express M.2™ Specification Revision 3.0, Version 1.2), a generic M.2 Slot B-compatible edge connector on the motherboard uses a mechanical key to mate with the 67-pin notched module connector.</li> <li>Manufacturers include LOTES (part #APCI0018-P001A01), Kyocera, JAE, Tyco, and</li> </ul> |
|   | Longwell.  |

a. Manufacturers/part numbers are for reference only and are subject to change. Choose connectors that are appropriate for your own design.

## 1.12 Integration Guidance

When integrating the EM91 Embedded Module, the following items, if applicable, must be considered:

- Mounting Effect on temperature, shock, and vibration performance
- Power supply Impact on battery drain and possible RF interference
- Antenna location and type Impact on RF performance
- Regulatory approvals As discussed in Regulatory Compliance and Industry Certifications on page 75.
- Service provisioning Manufacturing process
- Software As discussed in Software on page 65.
- Host interface Compliance with interface voltage levels

b. EM9190 only

# 2: Electrical Specifications

The system block diagram in Figure 2-1 on page 21 represents the EM91 module integrated into a host system. The module includes the following interfaces to the host:

- Full\_Card\_Power\_Off# Active-low input from the host Low turns the module off, high turns the module on.
- W\_DISABLE# Active low input from the host Low disables the main RF radio or triggers a 'Dying Gasp' SMS, depending on configuration.
- GPS\_DISABLE#—Active low input from the host—Low disables the GNSS radio receiver.
- WAKE\_ON\_WAN#—Active low output to the host—Low wakes the host when specific events occur.
- RESET# Active low input from the host Low resets the module.
- Antenna Four LTE/Sub-6G RF connectors and eight mmWave IF connectors (EM9190 only) to support up to four mmWave antennas. For details, see RF Specifications on page 41.
- Dynamic power control (DPR) Signal used to adjust Tx power to meet FCC SAR requirements. For details, see Tx Power Control on page 39.).
- SIMs:
  - External SIM The SIM Holder/tray is mounted on the host platform.
  - · Internal SIM A SIM may be mounted/embedded internal to the module (SKU-dependent).
  - Either the external or internal SIM can be active the active SIM can be specified through configuration or software control.
- SIM detect Internal pull-up on the module detects whether a SIM is present or not:
  - If a SIM is not inserted, the pin must be shorted to ground.
  - · If a SIM is present, the pin will be an open circuit.
- USB USB 3.1 Gen2 interface to the host for data, control, debug and status information. (USB 2.0 backward-compatible. Note USB 2.0 operation is not officially tested or commercially supported.)
- PCle:
  - PCIe PCIe3.0 interface to the host for data, control, debug and status information. (PCIe2.0 backward-compatible)
  - PCIE\_DIS Host interface selection, high for USB, low or Hi-Z for PCIe

The EM91 module has three main interface areas — the host I/O connector, the LTE/Sub-6G RF connectors, and the mmWave IF (EM9190 only) connectors. Details of these interfaces are described in the sections that follow.

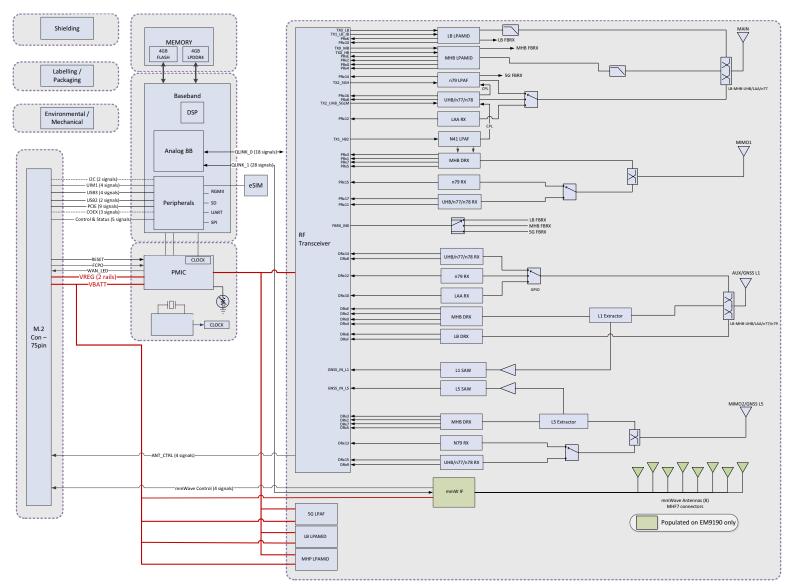


Figure 2-1: System Block Diagram

## 2.1 M.2 (Host) Interface Pin Assignments

The EM91 module's host I/O connector provides pins for power, serial communications, and control. Pin assignments are listed in Table 2-1.

Refer to the following tables for pin details based on interface types:

- Table 2-2, Power Supply Requirements, on page 28
- Table 2-3, USB Interface, on page 28
- Table 2-4, PCle Interface, on page 30
- Table 2-5, SIM Interface Signals, on page 32
- Table 2-6, Module Control Signals, on page 34
- Table 2-7, W\_DISABLE#/GPS\_DISABLE# Usage, on page 36
- Table 2-8, Full\_Card\_Power\_Off# and RESET# Usage, on page 36
- Table 2-10, mmWave Antenna Power Control Signals, on page 39

Note: Unless indicated otherwise, leave unused inputs and outputs as no-connects.

Note: The host must not drive any signals to the module until > 100 ms from the start of the power-on sequence.

Table 2-1: Host Interface (75-pin) Connections — Module View

|     |  | Pin               |  |                        | Active       | Voltage levels (V) |     |     |
|-----|--|-------------------|--|------------------------|--------------|--------------------|-----|-----|
| Pin | Signal name                                      | type <sup>a</sup> | Description                                  | Direction <sup>b</sup> | state        | Min                | Тур | Max |
| 1   | CONFIG_3<br>(NC in default module configuration) |                   | Reserved — Host must not repurpose this pin. |                        |              | -                  | _   | _   |
| 2   | VCC  | V                 | Power source                                 | Input                  | Power        | 3.135              | 3.3 | 4.4 |
| 3   | GND  | V                 | Ground                                       | Input                  | Power        | _                  | 0   | _   |
| 4   | VCC  | V                 | Power source                                 | Input                  | Power        | 3.135              | 3.3 | 4.4 |
| 5   | GND  | V                 | Ground                                       | Input                  | Power        | _                  | 0   | _   |
| 6   | Full Card Power Off#                             | PD                | Turn modem on                                | Input                  | High         | 1.0                | _   | 4.4 |
| O   | ruii_caiu_rowei_OII#                             | FD                | Turn modem off                               | Input                  | Low          | -0.3               | -   | 0.5 |
| 7   | USB_D+   | -                 | USB data positive                            | Input/Output           | Differential | _                  | -   | _   |

Table 2-1: Host Interface (75-pin) Connections — Module View (Continued)

|                 |  | Pin               |   |                        | Active       |       | Voltage levels (V) |      |
|-----------------|--|-------------------|---|------------------------|--------------|-------|--------------------|------|
| Pin             | Signal name                                | type <sup>a</sup> | Description   | Direction <sup>b</sup> | state        | Min   | Тур                | Max  |
| 8               | W_DISABLE#                                 | PU                | Wireless Disable (WWAN radio) or Dying Gasp trigger   | Input                  | Low          | _     | -                  | 0.4  |
| 0               | W_DISABLE#                                 | PU                | wheless disable (www.hiviadio) of Dyilig dasp trigger | Input                  | High         | 0.7   | _                  | 4.4  |
| 9               | USB_D-                                     | -                 | USB data negative                                     | Input/Output           | Differential | _     | _                  | _    |
| 10              | WWAN_LED#                                  | ОС                | LED Driver  | Output                 | Low          | 0     | _                  | 0.15 |
| 11              | GND  | V                 | Ground  | Input                  | Power        | _     | 0                  | _    |
| 12              | Кеу  | Notch lo          | cation  |                        |              |       |                    |      |
| 13              | Кеу  | Notch lo          | cation  |                        |              |       |                    |      |
| 14              | Кеу  | Notch lo          | cation  |                        |              |       |                    |      |
| 15              | Кеу  | Notch lo          | cation  |                        |              |       |                    |      |
| 16              | Кеу  | Notch lo          | cation  |                        |              |       |                    |      |
| 17              | Кеу  | Notch lo          | cation  |                        |              |       |                    |      |
| 18              | Кеу  | Notch lo          | cation  |                        |              |       |                    |      |
| 19              | Key  | Notch lo          | cation  |                        |              |       |                    |      |
| 20              | PCIE_DIS                                   | PD                | Host interface selection                              | Input                  | High         | 1.35  | 1.80               | 2.10 |
| 20              | PCIE_DIS                                   | PD                | nost illerrace selection                              | Input                  | Low          | -0.3  | _                  | 0.5  |
| 21              | CONFIG_O<br>(GND in default configuration) | V                 | Reserved — Host must not repurpose this pin.          | Output                 | _            |       | 0                  |      |
| 22              | VBUS_SENSE                                 | PD                | USB Detection   | Input                  | High         | 1.6   | -                  | 5.25 |
| 23              | WAKE_ON_WAN#                               | OC                | Wake Host   | Output                 | Low          | 0     | -                  | 0.1  |
| 24 <sup>c</sup> | VCC  | V                 | Power source  | Input                  | Power        | 3.135 | 3.3                | 4.4  |
| 25              | DPR  | _                 | Dynamic power control                                 | Input                  | High         | 1.17  | 1.80               | 2.10 |
| 25              | DPK  | -                 | bynamic power control                                 | Input                  | Low          | -0.3  | _                  | 0.63 |

Table 2-1: Host Interface (75-pin) Connections — Module View (Continued)

|     |               | Pin               |                                |   | 0 ativa      |                                    | Voltage levels (V                |                                  |
|-----|---------------|-------------------|--------------------------------|---|--------------|------------------------------------|----------------------------------|----------------------------------|
| Pin | Signal name   | type <sup>a</sup> | Description                    | Direction <sup>b</sup>  | state        | Min                                | Тур                              | Max                              |
| 26  | GPS_DISABLE#  | PU                | Wireless disable (GNSS radio)  | Input   | Low          | -                                  | _                                | 0.4                              |
| 20  | GP3_DI3ABLE#  | PU                | Wileless disable (div33 Faulo) | Input   | High         | 0.7                                | _                                | 4.4                              |
| 27  | GND           | V                 | Ground                         | Input   | Power        | _                                  | 0                                | _                                |
| 28  | PLA_S2#       | 0                 | Power loss acknowledge         | Output  | High         | 1.17                               | 1.80                             | 2.10                             |
| 20  | 1 LA_32#      | O                 | 1 ower 1033 dentiowiedge       | Input Low Input High Input Power  High Output Differential Low Output High  Output High  Input Low Output High  Input High  Input Differential Low Output High  Input High  Input High  Input Low  Input Low  Input Low  Input Low  Input Low | -0.3         | -                                  | 0.63                             |                                  |
| 29  | USB3_TXM      |                   | USB3 Negative Transmit Data    | Output  | Differential | -                                  | -                                | _                                |
|     |               |                   |                                |   | Low          | 0                                  | -                                | 0.45                             |
| 30  | 30 UIM1_RESET | 0                 | SIM Reset                      | Output  | High         | 2.55 (3V SIM)<br>1.35 (1.8V SIM)   | 3.00 (3V SIM)<br>1.80 (1.8V SIM) | 3.10 (3V SIM)<br>1.90 (1.8V SIM) |
| 31  | USB3_TXP      |                   | USB3 Positive Transmit Data    | Output  | Differential | -                                  | _                                | _                                |
|     |               |                   |                                |   | Low          | 0                                  | _                                | 0.45                             |
| 32  | UIM1_CLK      | 0                 | SIM Clock                      | Output  | High         | 2.55 (3V SIM)<br>1.35 (1.8V SIM)   | 3.00 (3V SIM)<br>1.80 (1.8V SIM) | 3.10 (3V SIM)<br>1.90 (1.8V SIM) |
| 33  | GND           | V                 | Ground                         | Input   | Power        | -                                  | 0                                | _                                |
|     |               |                   |                                | Input   | Low          | -0.30 (3V SIM)<br>-0.30 (1.8V SIM) | -                                | 0.60 (3V SIM)<br>0.35 (1.8V SIM) |
| 34  | UIM1_DATA     | -                 | SIM I/O pin                    |   | High         | 2.10 (3V SIM)<br>1.17 (1.8V SIM)   | 3.00 (3V SIM)<br>1.80 (1.8V SIM) | 3.30 (3V SIM)<br>2.10 (1.8V SIM) |
|     |               |                   |                                |   | Low          | 0                                  | -                                | 0.40                             |
|     |               |                   |                                | Output  | High         | 2.55 (3V SIM)<br>1.35 (1.8V SIM)   | 3.00 (3V SIM)<br>1.80 (1.8V SIM) | 3.10 (3V SIM)<br>1.90 (1.8V SIM) |
| 35  | USB3_RXM      |                   | USB3 Negative Receive Data     | Input   | Differential | -                                  | -                                | _                                |

Table 2-1: Host Interface (75-pin) Connections — Module View (Continued)

|                 |                          | Pin               |  |                        | Active       |                                  | Voltage levels (V                |                                  |
|-----------------|--------------------------|-------------------|--|------------------------|--------------|----------------------------------|----------------------------------|----------------------------------|
| Pin             | Signal name              | type <sup>a</sup> | Description  | Direction <sup>b</sup> | state        | Min                              | Тур                              | Max                              |
| 36              | UIM1_PWR                 | V                 | SIM VCC supply   | Output                 | Power        | 2.90 (3V SIM)<br>1.75 (1.8V SIM) | 3.00 (3V SIM)<br>1.80 (1.8V SIM) | 3.10 (3V SIM)<br>1.85 (1.8V SIM) |
| 37              | USB3_RXP                 |                   | USB3 Positive Receive Data                             | Input                  | Differential | _                                | -                                |                                  |
| 38 <sup>c</sup> | VCC                      | V                 | Power source   | Input                  | Power        | 3.135                            | 3.3                              | 4.4                              |
| 39              | GND                      | V                 | Ground   | Input                  | Power        | -                                | 0                                | _                                |
| 40              | QTMO PON <sup>d</sup>    | 0                 | mmWave antenna module Power On signal (from EM9190)    | Outout                 | High         | 1.35                             | -                                | 1.8                              |
| 40              | QTMO_PON                 | U                 | minwave antenna module Power on Signal (from EM9 190)  | Output                 | Low          | 0                                | -                                | 0.45                             |
| 41              | PCIE_TXM0                |                   | PCIe Negative Transmit Data                            | Output                 | Differential | -                                | -                                | _                                |
| 42              | QTM1_PON <sup>d</sup>    | 0                 | mmWave antenna module Power On signal (from EM9190)    | Output                 | High         | 1.35                             | -                                | 1.8                              |
| 42              | QTMT_PON                 | U                 | minwave antenna module Power On Signal (nom Livis 190) | Output                 | Low          | 0                                | -                                | 0.45                             |
| 43              | PCIE_TXP0                |                   | PCIe Positive Transmit Data0                           | Output                 | Differential | -                                | -                                | _                                |
| 44              | QTM2_PON <sup>d</sup>    | 0                 | mmWave antenna module Power On signal (from EM9190)    | Output                 | High         | 1.35                             | _                                | 1.8                              |
| 44              | QTMZ_PON                 | U                 | minwave antenna module Power On Signal (nom EM9190)    | Output                 | Low          | 0                                | _                                | 0.45                             |
| 45              | GND                      | V                 | Ground   | Input                  | Power        | _                                | 0                                | _                                |
| 46              | QTM3_PON <sup>d</sup>    | 0                 | mmWave antenna module Power On signal (from EM9190)    | Output                 | High         | 1.35                             | _                                | 1.8                              |
| 40              | QTM3_PON                 | U                 | minwave antenna module Power On Signal (nom EM9190)    | Output                 | Low          | 0                                | _                                | 0.45                             |
| 47              | PCIE_RXM0                |                   | PCIe Negative Receive Data0                            | Input                  | Differential | _                                | _                                | _                                |
| 48              | QTM_IO_1.9V <sup>d</sup> | V                 | 1.904 V power supply                                   | Output                 | Power        | 1.8                              | 1.904                            | 2                                |
| 49              | PCIE_RXP0                |                   | PCIe Positive Receive Data0                            | Input                  | Differential | _                                | -                                | _                                |
| 50              | PCIE_PERST_N             |                   | DCIa Dasat   | Input                  | Low          | 0                                | -                                | 0.7                              |
| 50              | LCIE LEKOI IN            |                   | PCIe Reset   |                        | High         | 1.5                              | -                                | VCC                              |
| 51              | GND                      | V                 | Ground   | Input                  | Power        | -                                | 0                                | _                                |

Table 2-1: Host Interface (75-pin) Connections — Module View (Continued)

|                 |               | Pin               |  |                        | Active       |       | Voltage levels (V                                   | )    |
|-----------------|---------------|-------------------|--|------------------------|--------------|-------|---|------|
| Pin             | Signal name   | type <sup>a</sup> | Description  | Direction <sup>b</sup> | state        | Min   | Тур   | Max  |
| 52              | PCIE_CLKREQ_N | OC                | PCIe Clock Request   | Output                 | Low          | 0     | -   | 0.35 |
| 53              | PCIE_REFCLKM  |                   | PCIe Negative Reference Clock  | Input                  | Differential | _     | _   | _    |
| 54              | PCIE_PEWAKE_N | ОС                | PCIe Wake  | Output                 | Low          | 0     | _   | 0.35 |
| 55              | PCIE_REFCLKP  |                   | PCle Positive Reference Clock  | Input                  | Differential | _     | _   | _    |
| 56              | NC            |                   | Reserved — Host must not repurpose this pin.   |                        |              |       |   |      |
| 57              | GND           | V                 | Ground   | Input                  | Power        | _     | 0   | -    |
| 58              | NC            |                   | Reserved — Host must not repurpose this pin.   |                        |              |       |   |      |
| F0              | ANT CTDLO     |                   | Estample of the control of the contr | Output                 | High         | 1.35  | -   | 1.8  |
| 59              | ANT_CTRLO     |                   | External antenna tuner control   | Output                 | Low          | 0     | _   | 0.45 |
| 60              | Reserved      |                   | Reserved — Host must not repurpose this pin.   |                        |              |       |   |      |
| <i>C</i> 4      | ANT CTDI 4    |                   | D. If FMO2 WITH  | Output                 | High         | 1.35  | _   | 1.80 |
| 61              | ANT_CTRL1     |                   | Reserved for EM92xx compatibility  | Output                 | Low          | 0     | _   | 0.45 |
| 62              | Reserved      |                   | Reserved — Host must not repurpose this pin.   |                        |              |       |   |      |
| 63              | ANT CTPL 2    |                   | D. If FMO2 WITH  | Output                 | High         | 1.35  | _   | 1.80 |
| 63              | ANT_CTRL2     |                   | Reserved for EM92xx compatibility  | Output                 | Low          | 0     | _   | 0.45 |
| 64              | Reserved      |                   | Reserved — Host must not repurpose this pin.   |                        |              |       |   |      |
| 65              | ANT CTPL 2    |                   | D. L. FAMOS MILIT  | Output                 | High         | 1.35  | _   | 1.80 |
| 65              | ANT_CTRL3     |                   | Reserved for EM92xx compatibility  | Output                 | Low          | 0     | _   | 0.45 |
| 66              | SIM1_DETECT   | PU                | SIM indication   | Input                  |              | · ·   | 0 V — SIM not present<br>Open circuit — SIM present |      |
| 67              | RESET#        | PU                | Reset module   | Input                  | Low          | -0.3  | -   | 0.63 |
| 68 <sup>c</sup> | VCC           | V                 | Power source   | Input                  | Power        | 3.135 | 3.3   | 4.4  |

Table 2-1: Host Interface (75-pin) Connections — Module View (Continued)

|     |  | Pin               |  |                        | Active |       | Voltage levels (V) |     |
|-----|--|-------------------|--|------------------------|--------|-------|--------------------|-----|
| Pin | Signal name                                      | type <sup>a</sup> | Description                                  | Direction <sup>b</sup> | state  | Min   | Тур                | Max |
| 69  | CONFIG_1<br>(GND in default configuration)       |                   | Reserved — Host must not repurpose this pin. | Output                 | _      |       | 0                  |     |
| 70  | VCC  | V                 | Power source                                 | Input                  | Power  | 3.135 | 3.3                | 4.4 |
| 71  | GND  | V                 | Ground                                       | Input                  | Power  | _     | 0                  | _   |
| 72  | VCC  | V                 | Power source                                 | Input                  | Power  | 3.135 | 3.3                | 4.4 |
| 73  | GND  | V                 | Ground                                       | Input                  | Power  | _     | 0                  | _   |
| 74  | VCC  | V                 | Power source                                 | Input                  | Power  | 3.135 | 3.3                | 4.4 |
| 75  | CONFIG_2<br>(NC in default module configuration) | V                 | Reserved — Host must not repurpose this pin. |                        | _      | _     |                    | _   |

a. I—Input; O—Digital output; OC—Open Collector output; PU—Digital input (internal pull-up); PD—Digital input (internal pull-down); V—Power or ground
 b. Signal directions are from module's point of view (e.g. 'Output' from module to host, 'Input' to module from host.)
 c. VCC pins 24/38/68—Optional to leave NC for EM7690.

d. These pins are NC for EM9191/EM7690.

# 2.2 Power Supply

The host provides power to the EM91 module through multiple power and ground pins as summarized in Table 2-2.

The host must provide safe and continuous power (via battery or a regulated power supply) at all times; the module does not have an independent power supply, or protection circuits to guard against electrical issues.

Table 2-2: Power Supply Requirements

| Name       | Pins  | Specification  |                       | Min | Тур | Max  | Units             |
|------------|---|----------------|-----------------------|-----|-----|------|-------------------|
|            |   | Voltage range  | 3.135                 | 3.3 | 4.4 | V    |                   |
|            |   | Ripple voltage |                       | -   | -   | 100  | mV <sub>pp</sub>  |
|            |   |                | EM9190 with mmWave    | -   | -   | 5000 |                   |
|            |   | Peak current   | EM9190 without mmWave | -   | -   | 3000 | mΛ                |
| VCC (3.3V) | 2, 4, 24, 38, 68, 70,<br>72, 74             | Peak current   | EM9191                | -   | -   | 2700 | - mA<br>-<br>- mA |
| VCC (3.3V) |   |                | EM7690                | -   | -   | 2300 |                   |
|            |   |                | EM9190 with mmWave    | -   | -   | 4000 |                   |
|            |   | Continuous     | EM9190 without mmWave | -   | -   | 2300 |                   |
|            |   | current        | EM9191                | -   | -   | 2000 |                   |
|            |   |                | EM7690                | -   | -   | 1600 |                   |
| GND        | 3, 5, 11, 27, 33, 39,<br>45, 51, 57, 71, 73 | -              |                       | -   | 0   | -    | V                 |

#### 2.3 USB Interface

**Important:** Host support for USB 3.1 signals is required when USB is selected as the host interface.

The EM91 module supports a USB 3.1 Gen2 interface for communication between the host and module. (USB 2.0 backward-compatible. Note — USB 2.0 operation is not officially tested or commercially supported.)

The USB interface complies with the [21] Universal Serial Bus Specification, Rev 2.0 and [22] Universal Serial Bus Specification, Rev 3.1 (subject to limitations described below), and the host platform must be designed to the same standards.

Table 2-3: USB Interface

| Name                  | Pin | Description                               |  |
|-----------------------|-----|---|--|
| USB_D+                | 7   | (USB 2 High speed) Data positive          |  |
| USB_D-                | 9   | (USB 2 High speed) Data negative          |  |
| VBUS_SENSE            | 22  | USB detection                             |  |
| USB3_TXM <sup>a</sup> | 29  | (USB 3 Superspeed) Transmit data negative |  |

Table 2-3: USB Interface (Continued)

| Name                  | Pin | Description                               |  |
|-----------------------|-----|---|--|
| USB3_TXP <sup>a</sup> | 31  | (USB 3 Superspeed) Transmit data positive |  |
| USB3_RXM <sup>a</sup> | 35  | (USB 3 Superspeed) Receive data negative  |  |
| USB3_RXP <sup>a</sup> | 37  | (USB 3 Superspeed) Receive data positive  |  |

a. Signal directions (Tx/Rx) are from the module's point of view.

Note: USB cannot be identified until VBUS\_SENSE is connected.

#### 2.3.1 Host-side Recommendation

Series capacitors are recommended on the host-side USB3 Rx signals (no capacitors required for the Tx signals), as shown below.

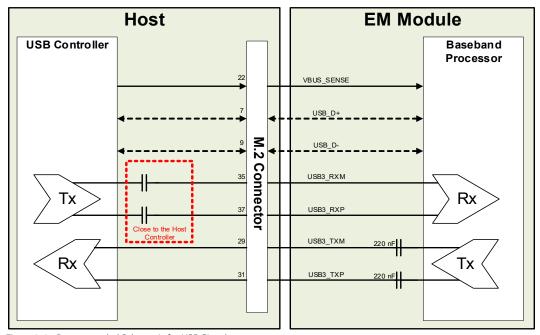


Figure 2-2: Recommended Schematic for USB Signals

#### 2.4 PCle Interface

**Important:** Host support for PCle 3.0 signals is required (for performance purposes) when PCle is selected as host interface.

The EM91 module supports a PCIe interface for communication between the host and module.

The PCIe interface complies with the PCI Express<sup>®</sup> Card Electromechanical Specification Revision 3.0 (2.0 backward-compatible), and the host platform must be designed to the same standards.

Table 2-4: PCIe Interface

|      | Name                   | Pin | Description                   |
|------|------------------------|-----|-------------------------------|
|      | PCIE_TXM0 <sup>a</sup> | 41  | PCIe Negative Transmit Data0  |
|      | PCIE_TXP0 <sup>a</sup> | 43  | PCIe Positive Transmit Data0  |
|      | PCIE_RXM0 <sup>a</sup> | 47  | PCIe Negative Receive Data0   |
|      | PCIE_RXP0 <sup>a</sup> | 49  | PCIe Positive Receive Data0   |
| PCle | PCIE_PERST_N           | 50  | PCIe Reset                    |
|      | PCIE_CLKREQ_N          | 52  | PCIe Clock Request            |
|      | PCIE_REFCLKM           | 53  | PCIe Negative Reference Clock |
|      | PCIE_PEWAKE_N          | 54  | PCIe Wake                     |
|      | PCIE_REFCLKP           | 55  | PCIe Positive Reference Clock |

a. Signal directions (Tx/Rx) are from the module's point of view.

Note: EM91 modules support Active State Power Management (ASPM) L1 and LOs (PCIE\_CLKREQ\_N is required to support Clock Power Management in ASPM L1).

Note: EM91 modules do not have Optimized Buffer Flush/Fill (OBFF) support.

#### 2.4.1 Host-side Recommendation

Series capacitors are recommended on the host-side PCIe Rx signals (no capacitors required for the Tx signals). Also, pull-ups are recommended on the PCIE\_PEWAKE\_N and PCIE\_CLKREQ\_N signals, as shown below.

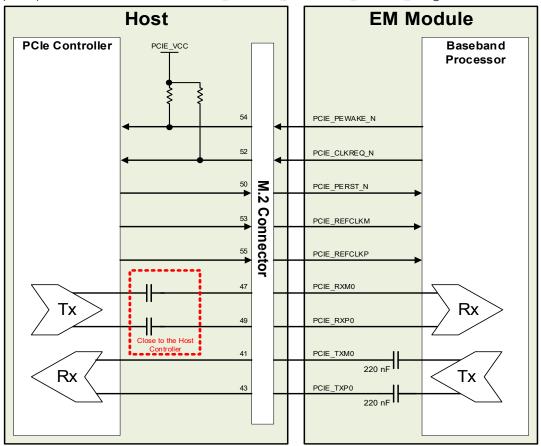


Figure 2-3: Recommended Schematic for PCIe Signals

#### 2.4.2 PCIE\_PEWAKE\_N

Depending on the host platform's configuration, PCEI\_PEWAKE\_N can be used by the module to wake the host when the PCIe link is in a power saving state.

For details, refer to [12] EM919x/EM7690 PCIe Integration Guide (Doc# 41114276).

#### 2.5 SIM Interface

Note: Host support for SIM interface signals is required.

The module supports one external SIM (Subscriber Identity Module) (1.8 V or 3 V). The SIM holds information for a unique account, enabling the customer to use the account on multiple devices.

The module may also include an M2M- or consumer-eUICC embedded SIM (eSIM). (SKU-dependent)

The SIM pins (Table 2-5 on page 32) provide the connections necessary to interface to SIM sockets located on the host platform as shown in Figure 2-4 on page 32. Voltage levels over this interface comply with 3GPP standards.

The SIM connector types used depend on how the host platform exposes the SIM sockets.

Table 2-5: SIM Interface Signals

| SIM      | Name       | Pin | Description    | SIM contact <sup>a</sup> | Notes   |
|----------|------------|-----|----------------|--------------------------|---|
|          | UIM1_RESET | 30  | Reset          | 2                        | Active low SIM reset  |
|          | UIM1_CLK   | 32  | Serial clock   | 3                        | Serial clock for SIM data   |
|          | UIM1_DATA  | 34  | Data I/O       | 7                        | Bi-directional SIM data line  |
| Drimonni | UIM1_PWR   | 36  | SIM voltage    | 1                        | Power supply for SIM  |
| Primary  | SIM_DETECT | 66  | SIM indication | -                        | Input from host indicating whether SIM is present or not  Grounded if no SIM is present  No-connect (floating) if SIM is inserted |
|          | UIM_GND    |     | Ground         | 5                        | Ground reference UIM_GND is common to module ground   |

a. See Figure 2-5 on page 33 for SIM card contacts.

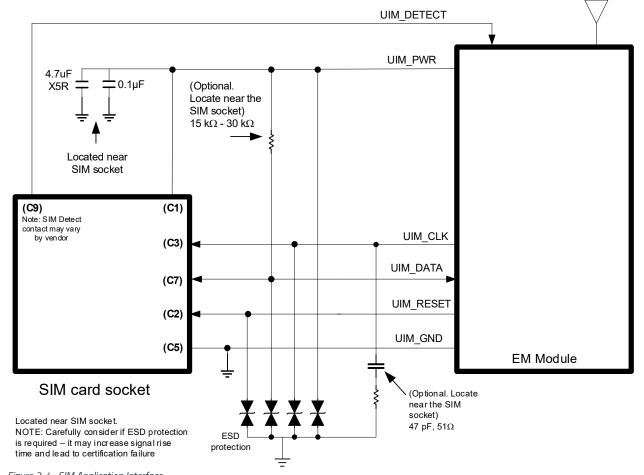


Figure 2-4: SIM Application Interface

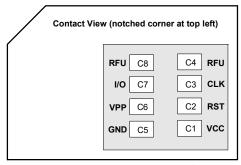


Figure 2-5: SIM Card Contacts (Contact View)

#### 2.5.1 SIM Implementation

Note: For interface design requirements, refer to ETSI TS 102 230 V5.5.0, section 5.2.

When designing the remote SIM interface, you must make sure that SIM signal integrity is not compromised.

Some design recommendations include:

- Total impedance of the VCC and GND connections to the SIM, measured at the module connector, should be less than 1 Ω to minimize voltage drop (includes any trace impedance and lumped element components inductors, filters, etc.).
- Position the SIM connector ≤10 cm from the module. If a longer distance is required because of the host platform design, use a shielded wire assembly — connect one end as close as possible to the SIM connector and the other end as close as possible to the module connector. The shielded assembly may help shield the SIM interface from system noise.
- Avoid routing the clock and data lines (UIM1\_CLK, UIM1\_DATA) in parallel over distances >2 cm—cross-coupling of a clock and data line pair can cause failures.
- 3GPP has stringent requirements for I/O rise time (<1 μs), signal level limits, and noise immunity consider this carefully when developing your PCB layout.
  - Keep signal rise time <1 µs keep SIM signals as short as possible, and keep very low capacitance traces on the data and clock signals (UIM1\_CLK, UIM1\_DATA). High capacitance increases signal rise time, potentially causing your device to fail certification tests.
- Add external pull-up resistors (15 k $\Omega$ -30 k $\Omega$ ), if required, between the data and power lines (UIM1\_DATA, UIM1\_PWR) to optimize the signal rise time.
- VCC line should be decoupled close to the SIM socket.
- Make sure that placement and routing of SIM signals and connectors supports SIM clock rates up to 5 MHz (per 3GPP specification).
- You must decide whether additional ESD protection is required for your product, as it is dependent on the platform, mechanical enclosure, and SIM connector design. The SIM pins will require additional ESD protection if they are exposed to high ESD levels (i.e. can be touched by a user).
- Putting optional decoupling capacitors on the SIM power line (UIM1\_PWR) near the SIM socket is recommended — the longer the trace length (impedance) from the socket to the module, the greater the capacitance requirement to meet compliance tests.
- Putting an optional series capacitor and resistor termination (to ground) on the clock line (UIM1\_CLK) at the SIM socket to reduce EMI and increase signal integrity is recommended if the trace length between the SIM socket and module is long a 47 pF capacitor and 50 Ω resistor are recommended.
- Test your first prototype host hardware with a Comprion IT<sup>3</sup> SIM test device at a suitable testing facility.

## 2.6 Control Interface (Signals)

The EM91 module provides signals for:

- Waking the host when specific events occur
- Host platform control of the module's radios
- Host platform control of module power
- Module status indication to host
- Host interface selection (i.e. PCIe, USB)

Note: Host support for Full\_Card\_Power\_Off# is required, and support for other signals in Table 2-6 is optional.

These signals are summarized in Table 2-6 and paragraphs that follow.

Table 2-6: Module Control Signals

| Name                 | Pin | Description                                      | Type <sup>a</sup> |
|----------------------|-----|--|-------------------|
| Full_Card_Power_Off# | 6   | On/off control                                   | PD                |
| W_DISABLE#           | 8   | Wireless disable (Main RF) or Dying Gasp trigger | PU                |
| WWAN_LED#            | 10  | LED driver                                       | OC                |
| PCIE_DIS             | 20  | Host interface selection                         | PD                |
| WAKE_ON_WAN#         | 23  | Wake host  | 0                 |
| GPS_DISABLE#         | 26  | Wireless disable (GNSS)                          | PU                |
| PLA_S2#              | 28  | Power loss acknowledge                           | 0                 |
| RESET#               | 67  | Reset module                                     | PU                |

a. 0 — Digital pin Output; OC — Open Collector output; PD — Digital pin Input, internal pull-down; PU — Digital pin Input, internal pin Input, internal pi

# 2.6.1 WAKE\_ON\_WAN# — Wake Host

Note: Host support for WAKE\_ON\_WAN# is optional.

The EM91 module uses WAKE\_ON\_WAN# to wake the host when specific events occur.

The host must provide a  $5-100~\text{k}\Omega$  pull-up resistor that considers total line capacitance (including parasitic capacitance) such that when WAKE\_ON\_WAN# is deasserted, the line will rise to 3.3 V (Host power rail) in < 100 ns.

See Figure 2-6 on page 35 for a recommended implementation.

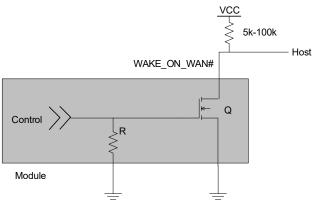


Figure 2-6: Recommended WAKE\_ON\_WAN# Connection

# 2.6.2 W\_DISABLE# (WWAN Disable) and GPS\_DISABLE# (GNSS Disable)

Note: Host support for WWAN/GNSS disable signals is optional.

The host platform can use W\_DISABLE# and GPS\_DISABLE# as follows:

 W\_DISABLE# — Control the radio state (enable/disable the WWAN or radio modem), or trigger a 'Dying Gasp' SMS when the platform is about to lose power.

Note: When the 'Dying Gasp' feature is enabled, W\_DISABLE# cannot be used to control the radio state. For details, refer to [1] Sierra Wireless EM9 Series AT Command Reference (Doc# 41113480) topics for !CUSTOM="DGENABLE", !WDISABLE, and !PCINFO.

GPS\_DISABLE#—Enable/disable GNSS functionality.

Letting these signals float high allows the module to operate normally. These pins have 100 k $\Omega$  pull-up resistors. See Figure 2-7 on page 36 for a recommended implementation.

When integrating with your host platform, keep the following in mind:

- The signal is an input to the module and should be driven LOW to turn the radio off, or HIGH or floating to keep it
  on.
- If the host never needs to assert this power state control to the module, leave this signal unconnected from the host interface.

Table 2-7: W\_DISABLE#/GPS\_DISABLE# Usage

| Name         | Pin | Description / notes   |  |  |  |  |
|--------------|-----|---|--|--|--|--|
| W_DISABLE#   | 8   | Feature configuration (Dying Gasp)-dependent behavior:  Enable / disable the WWAN or radio modem <sup>a</sup> . When disabled, the modem cannot transmit or receive.  Keep modem always on — Leave as not connected or drive HIGH.  Turn modem off — Drive LOW.  If the Dying Gasp feature is enabled, trigger a 'Dying Gasp' SMS.  |  |  |  |  |
| GPS_DISABLE# | 26  | <ul> <li>Enable/disable GNSS functionality<sup>a</sup></li> <li>Enable GNSS functionality—Leave as not connected or drive HIGH.</li> <li>Disable GNSS functionality—Drive LOW.</li> <li>For details on enabling/disabling GNSS functionality, refer to the AT!CUSTOM="GPSENABLE" command in [1] Sierra Wireless EM9 Series AT Command Reference (Doc# 41113480).</li> </ul> |  |  |  |  |

a. The host must implement an open collector driver where a Low signal turns off the modem or disables GNSS functionality, and a high signal turns on the modem or enables GNSS functionality.

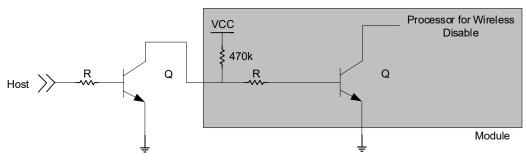


Figure 2-7: Recommended Wireless Disable Connection

#### 2.6.3 Full\_Card\_Power\_Off# and RESET#

 $Note:\ Host \, support \, for \, Full\_Card\_Power\_Off\#\, is \, required, \, and \, support \, for \, RESET\#\, is \, optional.$ 

Full\_Card\_Power\_Off# and RESET# are inputs to the module that the host uses as described in Table 2-8.

Table 2-8: Full\_Card\_Power\_Off# and RESET# Usage

| Name                 | Pin | Description / notes  |  |
|----------------------|-----|--|--|
| Full_Card_Power_Off# | 6   | <ul> <li>Powers the module on/off</li> <li>Signal is required.</li> <li>Pull HIGH to keep the module on. To keep the module always on:         <ul> <li>Tie the pin directly to a host GPIO (1.8V), or</li> <li>Use an external pull-up to pull signal high (10k-20 kΩ for 1.8V, 75-100 kΩ for VCC rail). Note that a larger-value resistor will reduce leakage current.</li> </ul> </li> <li>To power off the module, see Required Shutdown Sequence on page 63.</li> </ul> |  |

Table 2-8: Full\_Card\_Power\_Off# and RESET# Usage (Continued)

| Name   | Pin | Description / notes   |
|--------|-----|---|
| RESET# | 67  | Resets the module  Signal is optional. The module will operate correctly if the pin is left disconnected on the host.  This is a 'hard' reset, which should be used only if the host cannot communicate with the module via the PCle or USB port. (If the port is not working, the module may have locked up or crashed.)  To reset the module, pulse the RESET# pin with a logic low signal for 400–800 ms — if the signal is held low for more than 800 ms, the reset cycle restarts, and if it is held low through several cycles, the module will not fully boot. Otherwise, leave the signal floating or high impedance (the module will remain operational because the module has a pull-up resistor to an internal reference 1.8V voltage in place).  RESET#  High  Low  400–800 ms  The signal requires an open collector input from the host.  Caution: RESET# should not be driven or pulled to a logic high level by the host, as this may cause damage to the module. |

# 2.6.4 PLA\_S2# (Power Loss Acknowledge)

Note: Host support for PLA\_S2# is optional but highly recommended.

The PLA signal is asserted by the module when it has completed its power down operation. Once asserted, the host can safely remove power to the module.

For timing details, refer to Timing on page 61.

# 2.6.5 WWAN\_LED#—LED Output

Note: Host support for WWAN\_LED# is optional.

The configuration for the LED shown in Figure 2-8 is customizable. WWAN\_LED# supports up to 10 mA current sink. Contact your Sierra Wireless account representative for details.

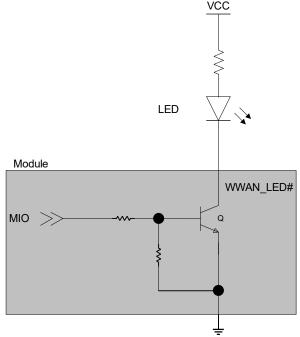


Figure 2-8: Recommended LED Connection

# 2.7 PCIE\_DIS — Interface Selection

Note: Host support for PCIE\_DIS is optional.

The PCIE\_DIS signal is provided for host interface selection:

- PCIe single lane interface Leave signal unconnected or tie to GND
- USB interface Drive signal high (1.8V)

#### **Switching Interfaces**

Typically, a host platform will configure the module for use with only one of these interfaces (i.e. the platform will be designed to use either PCle or USB, but not both.

However, if a platform must be able to switch between interfaces (e.g. a development kit that will be used to test both interfaces), the module must be power-cycled or reset to do the switch, because the interfaces are mutually-exclusive.

For example, if PCIE\_DIS is high when the module boots, the USB interface will be active.

To switch from USB to PCle interface:

- While the module is on, set PCIE\_DIS low.
   At this point, the module continues to use the USB interface.
- 2. While keeping PCIE\_DIS low, power cycle the module. When the module boots, it will use the PCIe interface.

(Follow the same basic process to switch from PCIe to USB — drive PCIe\_DIS high, then power cycle the module.)

#### 2.8 Tx Power Control

The module's SAR backoff state may be controlled using either SAR backoff AT commands (refer to [1] Sierra Wireless EM9 Series AT Command Reference (Doc# 41113480)), or the DPR (Dynamic Power Control) signal.

Use the GPIOSARENABLE parameter for **!CUSTOM** to choose the method.

- AT commands:
  - !SARSTATE Set (or report) the current SAR backoff state (override the default state). This change in state is non-persistent across power cycles.
- Dynamic power control:
  - The module's firmware monitors DPR (pin 25) with logic as detailed in Table 2-9, and adjusts the RF Tx power appropriately with the Smart Transmit feature. For details, refer to [11] EM919X-EM7690 Non-mmWave Smart Transmit (Doc# 2174291).

Table 2-9: DPR Logic

| !SARINTGPIOMODE <sup>a</sup> | DPR Internal Pull | DPR Pin           |  |
|------------------------------|-------------------|-------------------|--|
| 0 (default)                  | Pull-up           | High <sup>b</sup> |  |
| o (deradit)                  | Pull-up           | Low (Active)      |  |
| 1                            | Pull-down         | Low               |  |
| 1                            | Pull-uowii        | High (Active)     |  |

a. The AT command !SARINTGPIOMODE can be used to invert the DPR logic, as shown.

# 2.9 mmWave Antenna Power Control

Note: For EM9190 only. Host support for mmWave power control signals is optional.

The EM9190 provides five output signals (listed in Table 2-10) that are used to power on/off the mmWave antenna modules attached to the mmWave IF connectors.

Table 2-10: mmWave Antenna Power Control Signals

| Name        | Pin | Description  |
|-------------|-----|--|
| QTM0_PON    | 40  |  |
| QTM1_PON    | 42  | Dower control (on (off) signals for mm\\\) are antennas attached to the module's mm\\\\) are connecter |
| QTM2_PON    | 44  | Power control (on/off) signals for mmWave antennas attached to the module's mmWave connector           |
| QTM3_PON    | 46  |  |
| QTM_IO_1.9V | 48  | 1.904 V power supply, current limit is 500 mA  |

b. The host can implement an open collector drive for the DPR pin (if a 1.8V-compatible drive is not available).

# 2.10 Antenna Control

Note: Host support for the antenna control signal is optional.

The EM91 module provides one output signal (ANT\_CTRLO) listed in Table 2-11) that may be used for host designs that incorporate tunable low-band (< 1000 MHz) antennas. Customers can configure this signal as appropriate for the operating band(s) using the command AT!ANTSEL. (See [1] Sierra Wireless EM9 Series AT Command Reference (Doc# 41113480) for details.)

Table 2-11: Antenna Control Signals

| Name      | Pin | Description   |
|-----------|-----|---|
| ANT_CTRLO | 59  | Customer-defined external switch controls for tunable antennas. |
| ANT_CTRL1 | 61  |   |
| ANT_CTRL2 | 63  | Reserved for EM92xx compatibility                               |
| ANT_CTRL3 | 65  |   |

# 3: RF Specifications

#### 3.1 RF Antenna Connectors

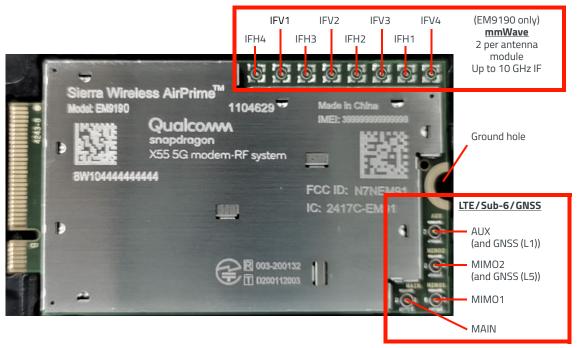


Figure 3-1: Module RF Connectors

EM91 modules include the following antenna connectors (Figure 3-1):

• LTE/Sub-6G/GNSS antenna connectors — Four MHF4 RF connectors for use with host-supplied antennas.

Table 3-1: Antenna Connectors — RF Technology Support

|                          |             |                |   |       | Rx   |       |       |     |
|--------------------------|-------------|----------------|---|-------|------|-------|-------|-----|
| Freq Range               |             | RAT            | Bands   | Tx    | MAIN | MIMO1 | MIMO2 | AUX |
| LB<br>(Low Band)         | < 1 GHz     | LTE/<br>Sub-6G | 5, 8, 12, 13, 14, 17, 18, 19,<br>20, 26, 28, 29, 71 | MAIN  | Υ    | _     | _     | Υ   |
| MLB<br>(Middle L-Band)   | 1.4-1.6 GHz | LTE/<br>Sub-6G | 32  | MAIN  | Υ    | Υ     | Υ     | Υ   |
| MB<br>(Mid Band)         | 1.7-2.2 GHz | LTE/<br>Sub-6G | 1, 2, 3, 4, 25, 34, 39, 66                          | MAIN  | Υ    | Υ     | Υ     | Υ   |
| НВ                       | 2.3-2.7 GHz | LTE/<br>Sub-6G | 7, 30, 38, 40                                       | MAIN  | Υ    | Υ     | Υ     | Υ   |
| (High Band)              |             | LTE only       | B41   | MAIN  | Υ    | Υ     | Υ     | Υ   |
|                          |             | Sub-6G         | n41   | MIMO1 | Υ    | Υ     | Υ     | Υ   |
| UHB<br>(Ultra High Band) | 3–5 GHz     | LTE/<br>Sub-6G | 42, 43, 48  | MAIN  | Υ    | Υ     | Υ     | Υ   |
|                          |             | LTE only       | B46 (Downlink only)                                 | _     | Υ    |       | _     | Υ   |

Table 3-1: Antenna Connectors — RF Technology Support (Continued)

|            |     |       |    | Rx   |       |       |     |
|------------|-----|-------|----|------|-------|-------|-----|
| Freq Range | RAT | Bands | Tx | MAIN | MIM01 | MIMO2 | AUX |
| GNSS L1    |     |       | _  | _    | _     | _     | Υ   |
| GNSS L5    |     |       | _  | _    | _     | Υ     | _   |

• (EM9190 only) mmW connectors — Eight MHF7S connectors for use with up to four mmWave antenna modules (2 connectors (H/V) per antenna module).

Note: mmWave IF connectors are mounted only on EM9190.

- Up to four mmWave antenna modules (QTM525 or QTM527) can connect to the EM9190. (Note EM9190 modules do not have integrated antennas.)
- Refer to Table 3-2 for specific QTM module band support.
- Refer to Table 3-3 for each pair of coaxial connections.
- · Note:
  - Low-power usage If fewer than four QTM525 modules are used, integration sequence from QTM0 to QTM3 is recommended. Leave unused connectors NC, and contact Sierra Wireless — the RFC must be updated to reflect the number of QTMs.
  - · High-power usage Four QTM527 modules should be equipped it is not recommended to leave any QTM527 NC as this will violate 3GPP EIRP compliance for PC1.

Note: To ensure the best mmWave performance, refer to [6] EM9190 mmWave Design Guidelines (Doc# 2174276), [9] EM9190 Low Power mmWave RF Customization File Preparation (Doc# 2174286), and [10] EM9190 High Power mmWave RF Customization File Preparation (Doc# 2174282).

Table 3-2: 5G NR Band Support by QTM Module Type

| Module    | n257 | n258 | n260 | n261 |
|-----------|------|------|------|------|
| QTM-525-2 | Υ    | Υ    | _    | Υ    |
| QTM-525-5 | Υ    | Υ    | Υ    | Υ    |
| QTM-527-1 | _    | _    | Y    | Υ    |
| QTM-527-2 | Υ    | Υ    | _    | Υ    |

Table 3-3: mmWave Port Assignments

|      |          | QTM525 IF port ↔ mmWave IF<br>connector |               | QTM527 IF port |               |
|------|----------|---|---------------|----------------|---------------|
| QTM  | P_ON     | IF1 IF2                                 |               | IF1            | IF2           |
| QTM0 | QTM0_PON | QTM0_H ↔ IFH1                           | QTMO_V ↔ IFV4 | QTM0_H ↔ IFH1  | QTM0_V ↔ IFV4 |
| QTM1 | QTM1_PON | QTM1_H ↔ IFH4                           | QTM1_V ↔ IFV1 | QTM1_H ↔ IFH2  | QTM1_V ↔ IFV3 |
| QTM2 | QTM2_PON | QTM2_H ↔ IFH2                           | QTM2_V ↔ IFV3 | QTM2_H ↔ IFH3  | QTM2_V ↔ IFV2 |
| QTM3 | QTM3_PON | QTM3_H ↔ IFH3                           | QTM3_V ↔ IFV2 | QTM3_H ↔ IFH4  | QTM3_V ↔ IFV1 |

#### 3.2 RF Connections

When attaching antennas to the module:

- LTE/Sub-6G/GNSS connectors:
  - Use RF plug connectors that are compatible with I-PEX (20449-001E (MHF4)) RF receptacle connectors.
  - Match coaxial connections between the module and the antenna to 50  $\Omega$ .
  - Minimize RF cable losses to the antenna; the recommended maximum cable loss for antenna cabling is 0.5 dB.
- mmWave connector (EM9190 only):
  - · Use RF plug connectors that are compatible with I-PEX (20981-001E-02 (MHF7S)) RF receptacle connectors.
  - · See mmWave Antennas on page 82 for mmWave antenna module tips.
- To ensure best thermal performance, use the ground hole (if possible) to attach (ground) the device to a metal chassis.

Note: If antenna connection is shorted or open, the modem will not sustain permanent damage.

### 3.2.1 Sub-6G Antennas and Cabling

When selecting sub-6G antennas and cables, it is critical to RF performance to match antenna gain and cable loss.

Note: There is no explicit list of antennas required in the host platform. The PWB-6-60-RSMAP Wide Band 4G/5G Terminal Paddle Antenna has been verified as a reference. For detailed electrical performance criteria, see Appendix A: Antenna Specification on page 79.

## 3.2.1.1 Choosing the Correct Sub-6G Antenna and Cabling

When matching antennas and cabling:

- The antenna (and associated circuitry) should have a nominal impedance of 50  $\Omega$  with a return loss of better than 10 dB across each frequency band of operation.
- The system gain value affects both radiated power and regulatory (FCC, IC, CE, etc.) test results.

#### 3.2.1.2 Designing Custom Sub-6G Antennas

Consider the following points when designing custom antennas:

- A skilled RF engineer should do the development to ensure that the RF performance is maintained.
- If multiple modules will be installed in the same platform, you may want to develop separate antennas for maximum performance.

#### 3.2.1.3 Determining the Sub-6G Antenna's Location

When deciding where to put the antennas:

- Antenna location may affect RF performance. Although the module is shielded to prevent interference in most host platforms, the placement of the antenna is still very important—if the host platform is insufficiently shielded, high levels of broadband or spurious noise can degrade the module's performance.
- Connecting cables between the module and the antenna must have 50  $\Omega$  impedance. If the impedance of the module is mismatched, RF performance is reduced significantly.
- Antenna cables should be routed, if possible, away from noise sources (switching power supplies, LCD assemblies, etc.). If the cables are near the noise sources, the noise may be coupled into the RF cable and into the antenna. See Interference from Other Wireless Devices on page 45.

#### 3.2.1.4 Disabling the Auxiliary (Diversity) Antenna

Certification testing of a device with an integrated EM91 module may require the module's MAIN and AUX (diversity) antennas to be tested separately.

To facilitate this testing, receive diversity can be enabled/disabled using the following AT command:

!RXDEN — Used to enable/disable diversity for single-cell call (no carrier aggregation).

**Important:** LTE networks expect modules to have more than one antenna enabled for proper operation. Therefore, customers must not commercially deploy their systems with the AUX (diversity) antenna disabled.

For details, refer to [1] Sierra Wireless EM9 Series AT Command Reference (Doc# 41113480).

Note: A diversity antenna is used to improve connection quality and reliability through redundancy. Because two antennas may experience difference interference effects (signal distortion, delay, etc.), when one antenna receives a degraded signal, the other may not be similarly affected.

# 3.3 Shielding

The module is fully shielded to protect against EMI. The shield must not be removed.

#### 3.4 Ground Connection

When connecting the module to system ground:

- Prevent noise leakage by establishing a very good ground connection to the module through the host connector.
- Connect to system ground using the ground hole shown in Figure 3-1 on page 41.
- Minimize ground noise leakage into the RF.
   Depending on the host board design, noise could potentially be coupled to the module from the host board. This is mainly an issue for host designs that have signals traveling along the length of the module, or circuitry operating at both ends of the module interconnects.

# 3.5 Interference and Sensitivity

Several interference sources can affect the module's RF performance (RF desense). Common sources include power supply noise and device-generated RF.

RF desense can be addressed through a combination of mitigation techniques (Methods to Mitigate Decreased Rx Performance on page 45) and radiated sensitivity measurement (Radiated Sensitivity Measurement on page 46).

Note: The EM91 module is based on ZIF (Zero Intermediate Frequency) technologies. When performing EMC (Electromagnetic Compatibility) tests, there are no IF (Intermediate Frequency) components from the module to consider.

#### 3.5.1 Interference from Other Wireless Devices

Wireless devices operating inside the host device can cause interference that affects the module.

To determine the most suitable locations for antennas on your host device, evaluate each wireless device's radio system, considering the following:

- Any harmonics, sub-harmonics, or cross-products of signals generated by wireless devices that fall in the module's Rx range may cause spurious response, resulting in decreased Rx performance.
- The Tx power and corresponding broadband noise of other wireless devices may overload or increase the noise floor of the module's receiver, resulting in Rx desense.

The severity of this interference depends on the closeness of the other antennas to the module's antenna. To determine suitable locations for each wireless device's antenna, thoroughly evaluate your host device's design.

#### 3.5.2 Host-generated RF Interference

All electronic computing devices generate RF interference that can negatively affect the receive sensitivity of the module.

Proximity of host electronics to the antenna in wireless devices can contribute to decreased Rx performance. Components that are most likely to cause this include:

- Microprocessor and memory
- Display panel and display drivers
- Switching-mode power supplies

## 3.5.3 Device-generated RF Interference

The module can cause interference with other devices. Wireless devices such as Sierra Wireless embedded modules transmit in bursts (pulse transients) for set durations (RF burst frequencies). Hearing aids and speakers convert these burst frequencies into audible frequencies, resulting in audible noise.

### 3.5.4 Methods to Mitigate Decreased Rx Performance

It is important to investigate sources of localized interference early in the design cycle. To reduce the effect of device-generated RF on Rx performance:

- Put the antenna as far as possible from sources of interference. The drawback is that the module may be less convenient to use.
- Shield the host device. The module itself is well shielded to avoid external interference. However, the antenna cannot be shielded for obvious reasons. In most instances, it is necessary to employ shielding on the components of the host device (such as the main processor and parallel bus) that have the highest RF emissions.
- Filter out unwanted high-order harmonic energy by using discrete filtering on low frequency lines.
- Form shielding layers around high-speed clock traces by using multi-layer PCBs.
- Route antenna cables away from noise sources.

## 3.5.5 Radiated Spurious Emissions (RSE)

When designing an antenna for use with Sierra Wireless embedded modules, the host device with a Sierra Wireless embedded module must satisfy any applicable standards/local regulatory bodies for radiated spurious emission (RSE) for receive-only mode and for transmit mode (transmitter is operating).

Note that antenna impedance affects radiated emissions, which must be compared against the conducted 50  $\Omega$  emissions baseline. (Sierra Wireless embedded modules meet the 50  $\Omega$  conducted emissions requirement.)

### 3.5.6 Radiated Sensitivity Measurement

A wireless host device contains many noise sources that contribute to a reduction in Rx performance.

To determine the extent of any receiver performance desensitization due to self-generated noise in the host device, over-the-air (OTA) or radiated testing is required. This testing can be performed by Sierra Wireless or you can use your own OTA test chamber for in-house testing.

#### 3.5.6.1 Sensitivity vs. Frequency

Sensitivity definitions for supported RATs:

- UMTS bands Sensitivity is defined as the input power level in dBm that produces a BER (Bit Error Rate) of 0.1%. Sensitivity should be measured at all UMTS frequencies across each band.
- LTE bands Sensitivity is defined as the RF level at which throughput is 95% of maximum.
- 5G NR Sub-6G bands (EM919x only) Sensitivity is defined as the RF level at which throughput is 95% of maximum.

# 3.6 Supported RATs

The EM91 module supports:

- 5G
  - Multiple-band 5G (EM919x only) See Table 3-4 (supported bands), Table 3-6 (NR bandwidth support) and Table 3-8 (Inter-band EN-DC NR UL combinations).
- LTE:
  - Multiple-band LTE See Table 3-4 (supported bands) and Table 3-5 on page 48 (LTE bandwidth support).
  - · LTE Advanced carrier aggregation:
    - · Intra-band ULCA 3C, 7C, 41C, 42C
    - · Inter-band ULCA Low band and mid-high band combinations. See Table 3-7.
- WCDMA:
  - Multiple-band WCDMA/HSPA/HSPA+/DC-HSPA+ See Table 3-4.
  - · Multiple-band WCDMA receive diversity
- inter-RAT and inter-frequency cell reselection and handover between supported frequency bands
- GNSS:
  - GPS, GLONASS, BeiDou, Galileo, QZSS—See Table 3-13 on page 55.

### 3.6.1 Supported Bands

Table 3-4: Supported Frequency Bands, by RAT (5G/LTE/3G)

| Band# | 5G <sup>a</sup> (n <band#)< th=""><th>LTE (B<band#>)</band#></th><th>3G (Band<band#)< th=""><th>Frequency (Tx)</th><th>Frequency (Rx)</th></band#)<></th></band#)<> | LTE (B <band#>)</band#> | 3G (Band <band#)< th=""><th>Frequency (Tx)</th><th>Frequency (Rx)</th></band#)<> | Frequency (Tx) | Frequency (Rx) |
|-------|---|-------------------------|--|----------------|----------------|
| 1     | Υ   | Y                       | Υ  | 1920-1980 MHz  | 2110-2170 MHz  |
| 2     | Υ   | Y                       | Υ  | 1850-1910 MHz  | 1930–1990 MHz  |
| 3     | Υ   | Y                       |  | 1710-1785 MHz  | 1805–1880 MHz  |
| 4     |   | Y                       | Υ  | 1710-1755 MHz  | 2110-2155 MHz  |
| 5     | Υ   | Y                       | Υ  | 824-849 MHz    | 869-894 MHz    |
| 6     |   |                         | Υ  | 830-840 MHz    | 875–885 MHz    |

Table 3-4: Supported Frequency Bands, by RAT (5G/LTE/3G) (Continued)

| Band#            | 5G <sup>a</sup> (n <band#)< th=""><th>LTE (B<band#>)</band#></th><th>3G (Band<band#)< th=""><th>Frequency (Tx)</th><th>Frequency (Rx)</th></band#)<></th></band#)<> | LTE (B <band#>)</band#> | 3G (Band <band#)< th=""><th>Frequency (Tx)</th><th>Frequency (Rx)</th></band#)<> | Frequency (Tx)  | Frequency (Rx)      |  |
|------------------|---|-------------------------|--|---|---------------------|--|
| 7                | $\lambda_p$   | Υ                       |  | 2500–2570 MHz 2620–2690 M                               |                     |  |
| 8                | Υb  | Y                       | Υ  | 880-915 MHz   | 925–960 MHz         |  |
| 9                |   |                         | Υ  | 1749.9-1784.9 MHz                                       | 1844.9-1879.9 MHz   |  |
| 12               | $\lambda_p$   | Υ                       |  | 699-716 MHz   | 729–746 MHz         |  |
| 13               |   | Υ                       |  | 777–787 MHz   | 746–756 MHz         |  |
| 14               |   | Υ                       |  | 788–798 MHz   | 758–768 MHz         |  |
| 17               |   | Υ                       |  | 704-716 MHz   | 734–746 MHz         |  |
| 18               |   | Υ                       |  | 815-830 MHz   | 860-875 MHz         |  |
| 19               |   | Υ                       | Υ  | 830-845 MHz   | 875-890 MHz         |  |
| 20               | Υb  | Υ                       |  | 832–862 MHz   | 791–821 MHz         |  |
| 25               | Υb  | Υ                       |  | 1850-1915 MHz   | 1930–1995 MHz       |  |
| 26               |   | Υ                       |  | 814-849 MHz   | 859-894 MHz         |  |
| 28               | Υ   | Υ                       |  | 703-748 MHz   | 758–803 MHz         |  |
| 29               |   | Y                       |  | n/a   | 717–728 MHz         |  |
| 30               |   | Y                       |  | 2305–2315 MHz<br>Note: B30 Tx is disabled. <sup>c</sup> | 2350-2360 MHz       |  |
| 32               |   | Y                       |  | n/a   | 1452-1496 MHz       |  |
| 34               |   | Y                       |  | 2010-2025   | MHz (TDD)           |  |
| 38               | Yb  | Υ                       |  | 2570-2620   | MHz (TDD)           |  |
| 39               |   | Y                       |  | 1880-1920   | MHz (TDD)           |  |
| 40               | Yb  | Y                       |  | 2300-24001  | MHz (TDD)           |  |
| 41               | Υ   | Υ                       |  | 2496-26901  | MHz (TDD)           |  |
| 42               |   | Υ                       |  | 3400-36001  | MHz (TDD)           |  |
| 43               |   | Υp                      |  | 3600-38001  | MHz (TDD)           |  |
| 46 <sup>d</sup>  |   | Υ                       |  | n/a   | 5150-5925 MHz (TDD) |  |
| 48               | Υb  | Υ                       |  | 3550–3700 MHz (TDD)                                     |                     |  |
| 66               | Υ   | Υ                       |  | 1710-1780 MHz   | 2110-2200 MHz       |  |
| 71               | Υ   | Υ                       |  | 663–698 617–652   |                     |  |
| 77               | Υ   |                         |  | 3300-4200 MHz (TDD)                                     |                     |  |
| 78               | Υ   |                         |  | 3300-3800 MHz (TDD)                                     |                     |  |
| 79               | Υ   |                         |  | 4400-5000 MHz (TDD)                                     |                     |  |
| 257 <sup>e</sup> | Υ   |                         |  | 26500–29500 MHz (TDD)                                   |                     |  |
| 258 <sup>e</sup> | Υ   |                         |  | 24250-27500   | ) MHz (TDD)         |  |

Table 3-4: Supported Frequency Bands, by RAT (5G/LTE/3G) (Continued)

| Band#            | 5G <sup>a</sup> (n <band#)< th=""><th>LTE (B<band#>)</band#></th><th>3G (Band<band#)< th=""><th>Frequency (Tx)</th><th>Frequency (Rx)</th></band#)<></th></band#)<> | LTE (B <band#>)</band#> | 3G (Band <band#)< th=""><th>Frequency (Tx)</th><th>Frequency (Rx)</th></band#)<> | Frequency (Tx)        | Frequency (Rx) |  |  |
|------------------|---|-------------------------|--|-----------------------|----------------|--|--|
| 260 <sup>e</sup> | Υ   |                         |  | 37000-40000 MHz (TDD) |                |  |  |
| 261 <sup>e</sup> | Υ   |                         |  | 27500-28350 MHz (TDD) |                |  |  |

- a. EM919x only
  b. Band support is firmware and SKU dependent.
  c. To assist OEMs to meet FCC and PTCRB rules, LTE band 30 is set to downlink only by default.
  d. LTE-LAA B46 (downlink only)
- e. EM9190 only

Table 3-5: LTE Bandwidth Supporta

| Band | 1.4 MHz | 3 MHz | 5 MHz | 10 MHz | 15 MHz         | 20 MHz         |
|------|---------|-------|-------|--------|----------------|----------------|
| B1   |         |       | Υ     | Υ      | Υ              | Υ              |
| B2   | Y       | Υ     | Υ     | Υ      | γb             | Yb             |
| В3   | Y       | Υ     | Υ     | Υ      | Υ <sup>b</sup> | Yb             |
| B4   | Y       | Υ     | Υ     | Υ      | Υ              | Υ              |
| B5   | Υ       | Υ     | Υ     | Υp     |                |                |
| В7   |         |       | Υ     | Υ      | γc             | γb,c           |
| B8   | Y       | Υ     | Υ     | γb     |                |                |
| B12  | Y       | Υ     | γb    | γb     |                |                |
| B13  |         |       | γb    | γb     |                |                |
| B14  |         |       | γb    | γb     |                |                |
| B17  |         |       | γb    | γb     |                |                |
| B18  |         |       | Υ     | γb     | γb             |                |
| B19  |         |       | Υ     | γb     | γb             |                |
| B20  |         |       | Υ     | Υp     | γb             | Υp             |
| B25  | Y       | Υ     | Υ     | Υ      | γb             | Υp             |
| B26  | Y       | Υ     | Υ     | Yp     | Υ <sup>b</sup> |                |
| B28  |         | Υ     | Υ     | γb     | γb             | γb,c           |
| B29  |         | Υ     | Υ     | Υ      |                |                |
| B30  |         |       | Υ     | γb     |                |                |
| B32  |         |       | Υ     | Υ      | Y              | Y              |
| B34  |         |       | Υ     | Υ      | Y              |                |
| B38  |         |       | Υ     | Υ      | γc             | Υ <sup>c</sup> |
| B39  |         |       | Υ     | Υ      | γc             | γc             |
| B40  |         |       | Υ     | Υ      | Υ              | Υ              |

Table 3-5: LTE Bandwidth Supporta (Continued)

| Band             | 1.4 MHz | 3 MHz | 5 MHz | 10 MHz | 15 MHz | 20 MHz |
|------------------|---------|-------|-------|--------|--------|--------|
| B41              |         |       | Υ     | Υ      | Υ      | Υ      |
| B42              |         |       | Υ     | Υ      | Υ      | Υ      |
| B43 <sup>d</sup> |         |       | Υ     | Υ      | Υ      | Υ      |
| B46              |         |       |       | Υ      |        | Υ      |
| B48              |         |       | Υ     | Υ      | Υ      | Υ      |
| B66              | Υ       | Υ     | Υ     | Υ      | Υ      | Υ      |
| B71              |         |       | Υ     | Yp     | γb     | Yp     |

- a. Table contents are derived from 3GPP TS 36.521-1 v15.5.0, table 5.4.2.1-1.
  b. Bandwidth for which a relaxation of the specified UE receiver sensitivity requirement (Clause 7.3 of 3GPP TS 36.521-1 v15.5.0) is
- c. Bandwidth for which uplink transmission bandwidth can be restricted by the network for some channel assignments in FDD/TDD coexistence scenarios in order to meet unwanted emissions requirements (Clause 6.6.3.2 of 3GPP TS 36.521-1 v15.5.0).
  d. Band support is firmware and SKU dependent.

Table 3-6: EM919x<sup>a</sup> NR Bandwidth<sup>b</sup> and 5G Architecture Support<sup>c</sup>

|                  |                     |                     |                     | (Default            | architect |        | Bandwidtl<br>rt: NSA — |                       | alone; SA —           | Standalon           | e)                    |                       |                       |
|------------------|---------------------|---------------------|---------------------|---------------------|-----------|--------|------------------------|-----------------------|-----------------------|---------------------|-----------------------|-----------------------|-----------------------|
| Band             | 5                   | 10                  | 15                  | 20                  | 25        | 30     | 40                     | 50                    | 60                    | 70                  | 80                    | 90                    | 100                   |
| n1               | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           | NSA,SA | NSA,SA                 |                       |                       |                     |                       |                       |                       |
| n2               | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           |        |                        |                       |                       |                     |                       |                       |                       |
| n3               | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA    | NSA,SA |                        |                       |                       |                     |                       |                       |                       |
| n5               | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           |        |                        |                       |                       |                     |                       |                       |                       |
| n7 <sup>d</sup>  | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           |        |                        |                       |                       |                     |                       |                       |                       |
| n8 <sup>d</sup>  | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           |        |                        |                       |                       |                     |                       |                       |                       |
| n12 <sup>d</sup> | NSA,SA <sup>e</sup> | NSA,SA <sup>e</sup> | NSA,SA <sup>e</sup> |                     |           |        |                        |                       |                       |                     |                       |                       |                       |
| n20 <sup>d</sup> | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           |        |                        |                       |                       |                     |                       |                       |                       |
| n25 <sup>d</sup> | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           |        |                        |                       |                       |                     |                       |                       |                       |
| n28              | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           | NSA,SA |                        |                       |                       |                     |                       |                       |                       |
| n38 <sup>d</sup> |                     |                     |                     | NSA,SA              |           |        |                        |                       |                       |                     |                       |                       |                       |
| n40 <sup>d</sup> |                     |                     |                     | NSA,SA              |           | NSA,SA | NSA,SA                 | NSA,SA                | NSA,SA                |                     | NSA,SA                |                       |                       |
| n41              |                     |                     |                     | NSA,SA              |           | NSA,SA | NSA,SA                 | NSA,SA                | NSA,SA                | NSA,SA <sup>e</sup> | NSA,SA                | NSA,SA                | NSA,SA                |
| n48 <sup>d</sup> |                     | NSA,SA <sup>e</sup> |                     | NSA,SA <sup>e</sup> |           |        | NSA,SA <sup>e</sup>    | NSA,SA <sup>e,f</sup> | NSA,SA <sup>e,f</sup> |                     | NSA,SA <sup>e,f</sup> | NSA,SA <sup>e,f</sup> | NSA,SA <sup>e,f</sup> |
| n66              | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           | NSA,SA | NSA,SA <sup>e</sup>    |                       |                       |                     |                       |                       |                       |
| n71              | NSA,SA              | NSA,SA              | NSA,SA              | NSA,SA              |           |        |                        |                       |                       |                     |                       |                       |                       |
| n77              |                     |                     |                     | NSA,SA              |           | NSA,SA | NSA,SA                 | NSA,SA <sup>e</sup>   | NSA,SA                | NSA,SA <sup>e</sup> | NSA,SA                | NSA,SA <sup>e</sup>   | NSA,SA                |
| n78              |                     |                     |                     | NSA,SA              |           | NSA,SA | NSA,SA                 | NSA,SA                | NSA,SA                | NSA,SA              | NSA,SA                | NSA,SA                | NSA,SA                |

Table 3-6: EM919x<sup>a</sup> NR Bandwidth<sup>b</sup> and 5G Architecture Support<sup>c</sup> (Continued)

|      |   | Bandwidth (MHz)<br>(Default architecture support: NSA — Non-Standalone; SA — Standalone) |    |    |    |    |        |        |        |    |        |                     |                  |
|------|---|--|----|----|----|----|--------|--------|--------|----|--------|---------------------|------------------|
| Band | 5 | 10   | 15 | 20 | 25 | 30 | 40     | 50     | 60     | 70 | 80     | 90                  | 100              |
| n79  |   |  |    |    |    |    | NSA,SA | NSA,SA | NSA,SA |    | NSA,SA | NSA,SA <sup>e</sup> | NSA,SA           |
| n257 |   |  |    |    |    |    |        | NSA    |        |    |        |                     | NSA <sup>e</sup> |
| n258 |   |  |    |    |    |    |        | NSA    |        |    |        |                     | NSA <sup>e</sup> |
| n259 |   |  |    |    |    |    |        | NSA    |        |    |        |                     | NSA              |
| n260 |   |  |    |    |    |    |        | NSA    |        |    |        |                     | NSA              |

- a. EM919x only. Table contents are derived from 3GPP TS 38.521-1 v15.3.0, table 5.3.5-1.
- b. SCS: 30 kHz (FR1 TDD bands); 15 kHz (FR1 FDD bands); 120 kHz (FR2 bands)
- c. Architecture support is SKU-dependent. All FR1 bands capable of supporting Standalone (SA) and Non-standalone (NSA) architecture; FR2 bands support NSA only.
- d. Band support is firmware and SKU-dependent.
- e. Indicated bandwidths may be disabled by default due to carrier deployment requirements.
- f. Downlink only

# 3.6.2 CA/EN-DC Support

The following tables describe LTE UL CA and NR UL EN-DC support. For comprehensive LTE CA and NR EN-DC support details (including UL and DL combinations), refer to [15] EM9 Carrier Aggregations and EN-DC (Doc# 2174317).

Table 3-7: LTE Inter-band UL CA Summarya

| Mid-High Bands $ ightarrow$ | D4 | D2 | D. | D. | D.7 | DCC |
|-----------------------------|----|----|----|----|-----|-----|
| Low Bands ↓                 | B1 | B2 | B3 | B4 | В7  | B66 |
| B5                          | Υ  | Υ  | Υ  | Υ  | Υ   | Υ   |
| B8                          | Υ  |    | Υ  |    | Υ   |     |
| B12                         |    | Υ  |    | Υ  |     | Υ   |
| B13                         |    | Υ  |    | Υ  |     | Υ   |
| B18                         | Y  |    | Y  |    |     |     |
| B19                         | Y  |    | Y  |    |     |     |
| B20                         | Y  |    | Y  |    | Υ   |     |
| B26                         | Υ  |    | Υ  |    |     |     |
| B28                         | Υ  |    | Υ  |    | Υ   |     |

a. LTE UL CA summary only. For full LTE CA details, refer to [15] EM9 Carrier Aggregations and EN-DC (Doc# 2174317).

Table 3-8: NR UL Combination of EN-DCa

|      |                  | In                              | ter-band EN-DC (4G LTE Anchor's T | x)           |
|------|------------------|---------------------------------|-----------------------------------|--------------|
| NR E | Bands            | Low Band 4G                     | Mid Band 4G                       | High Band 4G |
|      | n1               | B8, B20                         |                                   |              |
|      | n2               | B5, B12                         |                                   |              |
|      | n3               | B8, B20, B28                    |                                   |              |
|      | n5               |                                 | B1, B2, B3, B66                   | B7, B30      |
|      | n7 <sup>b</sup>  | B5, B12, B20, B28               |                                   |              |
|      | n8 <sup>b</sup>  |                                 | B1, B3, B7                        |              |
|      | n12 <sup>b</sup> |                                 | B2, B66                           |              |
|      | n20 <sup>b</sup> |                                 | B1, B3, B7                        |              |
|      | n25 <sup>b</sup> | B12                             |                                   |              |
| FR1  | n28              |                                 | B1, B3                            | В7           |
|      | n38 <sup>b</sup> | B5, B12, B20, B71               |                                   |              |
|      | n40 <sup>b</sup> | B8, B28                         |                                   |              |
|      | n41              |                                 | B2, B3, B4, B25                   |              |
|      | n48 <sup>b</sup> | B13                             | B66                               |              |
|      | n66              | B5, B12, B13, B14, B71          |                                   |              |
|      | n71              |                                 | B2, B66                           | В7           |
|      | n77              | B8, B18, B28                    | B1, B3                            | B41          |
|      | n78              | B5, B8, B12, B18, B19, B20, B28 | B1, B2, B3, B66                   | B7, B38, B41 |
|      | n79              | B19                             | B1, B3, B39                       | B41          |

a. EM919x only. NR UL EN-DC summary only. For full NR EN-DC details, refer to [15] EM9 Carrier Aggregations and EN-DC (Doc# 2174317).
 b. Band support is firmware and SKU dependent.

# 3.7 Conducted Rx Sensitivity / Tx Power

Table 3-9: Typical Conducted Rx Sensitivity — NR Bandsa

|      |             |           |          | Typica |        | ted Rx Sens<br>IBm) <sup>b</sup> | itivity | Wo           | orst Case <sup>c</sup> |
|------|-------------|-----------|----------|--------|--------|----------------------------------|---------|--------------|------------------------|
| Band | Duplex Mode | SCS (KHz) | BW (MHz) | PRx    | DRx    | PRx+DRx                          | 4 Rx    | Antenna Port | Requirement (dBm)      |
| n1   | FDD         | 15        | 20       | -95.5  | -94    | -97                              | -100    | 4 Rx         | -95.8                  |
| n2   | FDD         | 15        | 20       | -95    | -94    | -97                              | -100.5  | 4 Rx         | -93.8                  |
| n3   | FDD         | 15        | 20       | -94.5  | -94    | -97                              | -100.5  | 4 Rx         | -92.8                  |
| n5   | FDD         | 15        | 20       | -95.5  | -97    | -100                             | n/a     | 2 Rx         | -90.1                  |
| n7   | FDD         | 15        | 20       | -96.5  | -95.0  | -97.5                            | -100.5  | 4 Rx         | -93.8                  |
| n8   | FDD         | 15        | 20       | -97.0  | -98.5  | -99.5                            | n/a     | 2 Rx         | -89.3                  |
| n12  | FDD         | 15        | 15       | -100.0 | -101.5 | -102.5                           | n/a     | 2 Rx         | -83.3                  |
| n20  | FDD         | 15        | 20       | -98.0  | -98.5  | -100.5                           | n/a     | 2 Rx         | -89.1                  |
| n25  | FDD         | 15        | 20       | -96.0  | -95.5  | -98.0                            | -101.0  | 2 Rx         | -89.6                  |
| n28  | FDD         | 15        | 20       | -95    | -97    | -99                              | n/a     | 2 Rx         | -90.1                  |
| n38  | TDD         | 30        | 20       | -96.0  | -95.5  | -97.5                            | -99.5   | 4 Rx         | -96                    |
| n40  | TDD         | 30        | 20       | -95.5  | -95.0  | -97.5                            | -99.5   | 4 Rx         | -96                    |
| n41  | TDD         | 30        | 20       | -96    | -95    | -98.5                            | -100.5  | 4 Rx         | -94                    |
| n48  | TDD         | 30        | 20       | -97.5  | -98.0  | -100.0                           | -102.0  | 4 Rx         | -94.1                  |
| n66  | FDD         | 15        | 20       | -93.5  | -93.5  | -96                              | -99     | 4 Rx         | -95.3                  |
| n71  | FDD         | 15        | 20       | -96.5  | -97.5  | -100                             | n/a     | 2 Rx         | -85.3                  |
| n77  | TDD         | 30        | 100      | -86.5  | -87.5  | -89                              | -91.5   | 4 Rx         | -86.8                  |
| n78  | TDD         | 30        | 40       | -91    | -92    | -94                              | -96.5   | 4 Rx         | -90.9                  |
| n79  | TDD         | 30        | 100      | -85.5  | -85.5  | -88                              | -89.5   | 4 Rx         | -86.8                  |

a. EM919x only

Table 3-10: Typical Conducted Rx (Receive) Sensitivity — LTE Bands at 10 MHz BW

| LTE   | Т     | Typical Conducted Rx sensitivity (dBm) <sup>a b</sup> |         |        |               |  |  |  |
|-------|-------|---|---------|--------|---------------|--|--|--|
| bands | PRx   | DRx   | PRx+DRx | 4 Rx   | PRx+DRx (dBm) |  |  |  |
| B1    | -98.5 | -98   | -102    | -104.5 | -96.3         |  |  |  |
| B2    | -99.5 | -98.5   | -101.5  | -103.5 | -94.3         |  |  |  |
| В3    | -98.5 | -98   | -100.5  | -103.5 | -93.3         |  |  |  |
| B4    | -99   | -99   | -101    | -104   | -96.3         |  |  |  |

b. Results at room temperature. Based on Lab test result and Call box only in a shielded test environment. There might be MSD for the cases which has harmonic and IMD exceptions, we guarantee better performance than the level that 3GPP defined.

c. Per 3GPP specification

Table 3-10: Typical Conducted Rx (Receive) Sensitivity — LTE Bands at 10 MHz BW (Continued)

| LTE              | 7      | Typical Conducted Rx ser | sitivity (dBm) <sup>a b</sup> |        | Worst Case <sup>c</sup> |
|------------------|--------|--------------------------|-------------------------------|--------|-------------------------|
| bands            | PRx    | DRx                      | PRx+DRx                       | 4 Rx   | PRx+DRx (dBm)           |
| B5               | -100   | -100                     | -103                          | _      | -94.3                   |
| В7               | -97    | -96                      | -100                          | -102.5 | -94.3                   |
| B8               | -100   | -100                     | -103                          | _      | -93.3                   |
| B12              | -100.5 | -101                     | -104                          | _      | -93.3                   |
| B13              | -101   | -101                     | -103.5                        | _      | -93.3                   |
| B14              | -101   | -101                     | -103.5                        | _      | -93.3                   |
| B17              | -100.5 | -101.5                   | -104                          | _      | -93.3                   |
| B18              | -100.5 | -101                     | -103.5                        | _      | -96.3                   |
| B19              | -100.5 | -100.5                   | -103                          | _      | -96.3                   |
| B20              | -100.5 | -100.5                   | -103.5                        | _      | -93.3                   |
| B25              | -98    | -97.5                    | -100.5                        | -103   | -92.8                   |
| B26              | -99    | -100.5                   | -102.5                        | _      | -93.8                   |
| B28              | -100.5 | -100.5                   | -103.5                        |        | -94.8                   |
| B29 <sup>d</sup> | -100.5 | -101                     | -103.5                        | _      | -93.3                   |
| B30              | -99    | -99                      | -101.5                        | -103   | -95.3                   |
| B32 <sup>d</sup> | -100   | -100                     | -102.5                        | -105   | -96.5                   |
| B34              | -98.5  | -97.5                    | -101                          | -104   | -96.3                   |
| B38              | -97    | -97                      | -100                          | -103   | -96.3                   |
| B39              | -98    | -98                      | -101                          | -103.5 | -96.3                   |
| B40              | -97    | -97                      | -100                          | -102.5 | -96.3                   |
| B41              | -97    | -97                      | -100                          | -102.5 | -94.3                   |
| B42              | -98    | -98.5                    | -101                          | -103.5 | -95.0                   |
| B43              | -99.0  | -95.5                    | -102.0                        | -104.5 | -95.0                   |
| B46 <sup>e</sup> | -94    | -94.5                    | -96.5                         | _      | -90                     |
| B48              | -98.5  | -98.5                    | -101.0                        | -103.5 | -95.0                   |
| B66              | -99    | -99                      | -101.5                        | -104   | -95.8                   |
| B71              | -101   | -101                     | -103.5                        | _      | -93.5                   |

a. Sensitivity values scale with bandwidth: x\_MHz\_Sensitivity = 10\_MHz\_Sensitivity - 10\*log (10 MHz/x\_MHz) Note: Bandwidth support is dependent on firmware version.

Results at room temperature. Based on Lab test result and Call box only in a shielded test environment, and the test is based on standalone mode only.

c. Per 3GPP specification

<sup>d. SDL (Rx only) band, and the typical result is based on certain 2DL CA cases such as B2+B29, B2+B46, B20+B32.
e. B46 is based on 20 MHz BW as most combinations for B46 LAA are 20 MHz BW only.</sup> 

Table 3-11: Conducted Rx (Receive) Sensitivity — UMTS Bands

|         |           | (                                 | Conducted Rx sensitiv  | ity (dBm)  |
|---------|-----------|-----------------------------------|------------------------|--|
| UMTS ba | nds       | Primary<br>(Typical) <sup>a</sup> | Secondary<br>(Typical) | Primary / Secondary<br>(Worst case) <sup>b</sup> |
| Band 1  |           | -110                              | -110                   | -106.0   |
| Band 2  |           | -110                              | -109                   | -104.0   |
| Band 4  |           | -110                              | -109.5                 | -106.0   |
| Band 5  | 0.1% BER  | -111                              | -112.5                 | -104.0   |
| Band 6  | 12.2 kbps | -111                              | -112.5                 | -106.0   |
| Band 8  |           | -111                              | -112.5                 | -103.0   |
| Band 9  |           | -109.5                            | -109.5                 | -105.0   |
| Band 19 |           | -111                              | -112.5                 | -106.0   |

a. The typical result is at room temperature and based on Lab test result and Call box only at a shielded test environment.

Table 3-12: Conducted Maximum Tx (Transmit) Power<sup>a</sup> Tolerances

| Bands           |                       | Conducted Tx Power     | Notes                               |  |  |  |  |
|-----------------|-----------------------|------------------------|-------------------------------------|--|--|--|--|
| 5G              |                       |                        |                                     |  |  |  |  |
| FR1 Sub-6G      | n2, n5, n48, n66, n77 | +23.7 dBm +0.8/-2.2 dB | EM919x only                         |  |  |  |  |
| Bands           | All other bands       | +23 dBm ± 1.5 dB       | Power Class 3                       |  |  |  |  |
| LTE             |                       |                        |                                     |  |  |  |  |
| LTE B3, B7, B4  | 1, B42                | +23 dBm +1.8/-1.0 dB   | Power Class 3                       |  |  |  |  |
| B41 HPUE        |                       | +25 dBm ± 1 dB         | Power Class 2 for B41 LTE mode only |  |  |  |  |
| LTE all other b | ands                  | +23 dBm ± 1 dB         | Power Class 3                       |  |  |  |  |
| UMTS            | UMTS                  |                        |                                     |  |  |  |  |
| All bands (12.2 | 2 kbps)               | +23.5 dBm ± 1 dB       | Connectorized (Power Class 3)       |  |  |  |  |

a. Tx Power is based on no maximum power reduction (MPR) configuration as 3GPP defined. For configurations that require MPR or additional MPR, refer to 3GPP for the power reduction.

b. Per 3GPP specification

# 3.8 GNSS Specifications

Note: For detailed electrical performance criteria, see Recommended GNSS Antenna Specifications on page 81.

Table 3-13: GNSS Specifications

| Parameter/feature        | Description   |
|--------------------------|---|
| Satellite channels       | Support all in-view satellites (L1 + L5) for simultaneous tracking  |
| TTFF <sup>a</sup>        | Hot start: ≤1 s<br>Warm start: ≤20 s<br>Cold start: ≤28 s   |
| Accuracy <sup>a</sup>    | Horizontal: < 2 m (50%); < 4 m (95%) Altitude: < 2 m (50%); < 4 m (95%) Velocity: < 0.2 m/s   |
| Sensitivity <sup>b</sup> | Tracking <sup>c</sup> :  GPS: -160 dBm  GLONASS: -158 dBm  Reacquisition <sup>d</sup> :  GPS: -157 dBm  GLONASS: -156 dBm  Cold start (autonomous) acquisition <sup>d</sup> :  GPS: -148 dBm  GLONASS: -140 dBm  Hot start acquisition <sup>d</sup> :  GPS: -155 dBm  GLONASS: -147 dBm |
| Operational Limits       | Altitude <6000 m or velocity <100 m/s (Either limit may be exceeded, but not both.)   |

- a. TTFF (without AGNSS) and accuracy are measured under open sky conditions with signal strength of -135 dBm.
- Performance is tested in conducted mode with GNSS signal simulator under room temperature and without external GNSS LNAs as the module includes internal LNAs for both L1 and L5.

  Tracking sensitivity is the lowest GNSS signal level in which the device can still detect in-view satellites and get fixed at least 50% of
- the time when in sequential tracking mode.

  Acquisition sensitivity is the lowest GNSS signal strength for which the device can still detect in-view satellites and get fixed at least 50% of the time.

# 4: Power

# 4.1 Power Consumption

Note: The power consumption data are measured with typical use cases of EM9190 for reference, refer to [8] EM9190 Current Consumption Application Note (Doc# 2174287) for details.

The module does not have its own power source and depends on the host device for power. For a description of input voltage requirements, see Power Supply on page 28.

Table 4-1: Averaged Standby DC Power Consumption

|        |  |                          | (         | Current <sup>b</sup> |      |                       |  |  |  |
|--------|--|--------------------------|-----------|----------------------|------|-----------------------|--|--|--|
| Signal | Description  | Bands <sup>a</sup>       | Тур       | Max                  | Unit | Notes / configuration |  |  |  |
|        | Standby current consumption (Host interface suspended <sup>c</sup> )         |                          |           |                      |      |                       |  |  |  |
|        | 5G   | NR bands                 | 2.7       | _                    | mA   | DRX cycle = 1.28 s    |  |  |  |
|        | LTE  | LTE bands                | 2.7       | _                    | mA   | DRX cycle = 1.28 s    |  |  |  |
|        | HSPA / WCDMA   | UMTS bands               | 2.6       | _                    | mA   | DRX cycle = 2.56 s    |  |  |  |
|        | Standby current consumption (Host interface active)                          |                          |           |                      |      |                       |  |  |  |
|        | 5G NR bands  |                          | 31.6      | _                    | mA   | DRX cycle = 1.28 s    |  |  |  |
|        | LTE LTE bands  |                          | 31.9      | _                    | mA   | DRX cycle = 1.28 s    |  |  |  |
| VCC    | HSPA / WCDMA   | UMTS bands               | 30.7      | _                    | mA   | DRX cycle = 2.56 s    |  |  |  |
|        | Low Power Mode (LPM) / Offline Mode (Host interface suspended <sup>c</sup> ) |                          |           |                      |      |                       |  |  |  |
|        | RF disabled, but module is op  | erational                | 5.0       | _                    | mA   |                       |  |  |  |
|        | Low Power Mode (LPM)/Off   | line Mode (Host interfac | e active) |                      | I.   | ,                     |  |  |  |
|        | RF disabled, but module is op  | 28.4                     | _         | mA                   |      |                       |  |  |  |
|        | Leakage Current  | Leakage Current          |           |                      |      |                       |  |  |  |
|        | Module powered off — Full_C<br>Low, and VCC is supplied                      | Card_Power_Off# is       | 70        | 120                  | μА   |                       |  |  |  |

a. For supported bands, see Table 3-4, Supported Frequency Bands, by RAT (5G/LTE/3G), on page 46.

b. Measured at 25°C/nominal 3.3 V voltage.

c. Indicated measurements assume the host interface is fully suspended (e.g., USB in USB SS, or PCIe in L1SS (see [12] EM919x/ EM7690 PCIe Integration Guide (Doc# 41114276) for details))

Table 4-2: Averaged Call Mode DC Power Consumption

| Mode                                 | Description                                      | Tx<br>power<br>(dBm) | Current <sup>a,b</sup><br>(mA) | Configuration <sup>c</sup>  | Bands          |  |
|--------------------------------------|--|----------------------|--------------------------------|---|----------------|--|
| 3G                                   | 3G Data Call,<br>max RF power                    | 23                   | 800                            | HSDPA DL 7.2 Mbps   | B1             |  |
|                                      |  | 0                    | 905                            | DL 2000 Mbps/UL 200 Mbps;   |                |  |
|                                      | LTE FDD DL<br>5CA 4×4 / UL<br>2CA                | 20                   | 1120                           | FDD, 20 MHz/CC,<br>DL: 5CC, 4×4 MIMO, 256QAM, RB=100, MCS=27;<br>UL: 2CC, 256QAM  |                |  |
| LTE                                  | LTE FDD DL                                       |                      | 1435                           | DL 2000 Mbps/UL 1 Mbps;  FDD, 20 MHz/CC, DL: 5CC, 4×4 MIMO, 256QAM, RB=100, MCS=27;  UL: 2CC, QPSK  | 1A+3C+7C       |  |
|                                      | PDCCH 1CC, no<br>data                            | _                    | 410                            | DL/UL 0 Gbps; Sub-6 100 MHz /CC, 4Rx, RB=0;<br>LTE no data  |                |  |
| Sub-6<br>NSA<br>Sub-6 DL / UL<br>1CC | Sub-6 DL / UL<br>1CC                             | 0                    | 660                            | DL 1600 Mbps/UL 95 Mbps;  Sub-6 100 MHz/CC, DL: duty cycle ~ 80%, 1CC, 4×4 MIMO, -50 dBm, 256QAM, RB=273, MCS=27;  UL: SISO, 256QAM, RB=273, MCS=27;  LTE no data   | 1A+n78         |  |
|                                      |  | 0                    | 1360                           | DL 3600 Mbps/200 Mbps;  |                |  |
| Sub-6                                | LTE 5CC + Sub-<br>6 DL / UL 1CC                  | 20                   | 1780                           | Sub-6 100 MHz/CC,<br>DL/UL duty cycle ~80/20, Rx: 1CC, 4×4 MIMO, -50 dBm, 256QAM,<br>RB=273, MCS=27;<br>Tx: SISO, 256QAM;<br>LTE: DL 5CC, 4×4 MIMO,20 MHz/CC, 256QAM, RB=100, MCS=27;<br>Tx: 256QAM             | - 1A+3C+7C+n78 |  |
| Sub-6<br>EN-DC                       | LTE 5CC + Sub-<br>6 DL / UL 1CC,<br>max RF power | 23                   | 2030                           | DL 3600 Mbps/UL 1 Mbps;  Sub-6 100 MHz/CC, DL/UL duty cycle ~80/20, Rx: 1CC, 4×4 MIMO, -50 dBm, 256QAM, RB=273, MCS=27;  Tx: SISO, QPSK; LTE: DL 5CC, 4×4 MIMO,20 MHz/CC, 256QAM, RB=100, MCS=27; Tx: SISO QPSK | 18+3C+/C+11/8  |  |

Table 4-2: Averaged Call Mode DC Power Consumption (Continued)

| Mode   | Description   | Tx<br>power<br>(dBm) | Current <sup>a,b</sup><br>(mA) | Configuration <sup>c</sup>  | Bands        |
|--------|---|----------------------|--------------------------------|---|--------------|
| mmWave | DL 4CC + UL<br>1CC<br>LTE UL 23 dBm,<br>max RF power              | 23                   | 1480 <sup>d</sup>              | DL 3.1 Gbps/UL TBD;  5G DL/UL duty cycle: ~80/20 mmW DL: 64QAM, 2×2 MIMO, Rx=-50 dBm;  mmW UL: 64QAM, Tx=21 dBm (TRP), SISO | 2A+66A+n261I |
| EN-DC  | DL 8CC <sup>e</sup> + UL<br>1CC<br>LTE UL 23 dBm,<br>max RF power | 23                   | 2000 <sup>d</sup>              | DL 5.1 Gbps/UL TBD;  5G DL/UL duty cycle: ~80/20 mmW DL: 64QAM, 2×2 MIMO, Rx=-50 dBm;  mmW UL: 64QAM, Tx=21 dBm (TRP), SISO | 2A+66A+n261M |

a. Measured at 25°C/nominal 3.3 V voltage

Table 4-3: Miscellaneous DC Power Consumption

|        |   |                       |   | urrent | /Volta | ge   |  |
|--------|---|-----------------------|---|--------|--------|------|--|
| Signal |   | Description           |   | Тур    | Max    | Unit | Description  |
|        | USB active current  PCle active current |                       | _ | 30     | _      | mA   | <ul> <li>High-speed USB connection, but no data transmission, CL = 50 pF on D+ and D- signals.</li> <li>RF is disabled.</li> </ul> |
|        |   |                       | _ | 53     | _      | mA   | <ul><li>PCle connection, but no data transmission.</li><li>RF is disabled.</li></ul>   |
| VCC    | Inrush cu                               | ush current           |   | _      | 3.0    | А    | <ul> <li>Assume power supply turn-on time &gt; 100 μs</li> <li>Dependent on host power supply rise time.</li> </ul>                |
|        |   | EM9190 with mmWave    | _ | _      | 5.0    | А    |  |
|        | Peak                                    | EM9190 without mmWave | _ | _      | 3.0    | А    | <ul> <li>Across all bands, all temperature ranges</li> </ul>   |
|        | current                                 | EM9191                | _ | _      | 2.7    | А    | ■ 3.3V supply  |
|        |   | EM7690                | _ | _      | 2.3    | А    |  |

Test data does not include current consumption of data transfer between module and host — the additional current increase is less than 100 mA in the worst case.

c. The measurement is using the EM919X/EM7690 development kit with a heatsink, refer to [3] EM9190 Thermal Application Note (Doc# 2174257) for details.

d. mmWave EN-DC current measurement is for the EM9190 only. QTM (mmW antenna) current is not included. e. 8CC is supported only on LE1.2/LE1.4.

# 4.2 Module Power States

The module has five power states, as described in Table 4-4.

Table 4-4: Module Power States

| State                        | Details  | Host is powered | Host interface active | RF enabled  |
|------------------------------|--|-----------------|-----------------------|-------------|
| Normal<br>(Default state)    | <ul> <li>Module is active</li> <li>Default state. Occurs when VCC is first applied, Full_Card_Power_Off# is deasserted (pulled high), and W_DISABLE# is deasserted</li> <li>Module is capable of placing/receiving calls, or establishing data connections on the wireless network</li> <li>Current consumption is affected by several factors, including:         <ul> <li>Radio band being used</li> <li>Transmit power</li> <li>Receive gain settings</li> <li>Data rate</li> </ul> </li> </ul> | V               | V                     | <b>&gt;</b> |
| Low power<br>(Airplane mode) | <ul> <li>Module is active</li> <li>Module enters this state:         <ul> <li>Under host interface control:</li> <li>Host issues AT+CFUN=0 ([16] AT Command Set for User Equipment (UE) (Release 6) (Doc# 3GPP TS 27.007)), or</li> <li>If the 'Dying Gasp' feature is currently disabled, and the Host asserts W_DISABLE# after AT!PCOFFEN=0 has been issued.</li> </ul> </li> <li>Automatically, when critical temperature or voltage trigger limits have been reached))</li> </ul>              | V               | V                     | ×           |
| Sleep                        | <ul> <li>Normal state of module between calls or data connections</li> <li>Module cycles between wake (polling the network) and sleep, at network provider-determined interval.</li> </ul>   | ~               | ×                     | ×           |
| Off                          | <ul> <li>Host keeps module powered off by asserting Full_Card_Power_Off# (signal pulled low or left floating)</li> <li>Module draws minimal current</li> <li>See Full_Card_Power_Off# and RESET# on page 36 for more information.</li> </ul>   | ~               | ×                     | ×           |
| Disconnected                 | Host power source is disconnected from the module and all voltages associated with the module are at 0 V.  | X               | ×                     | ×           |

### 4.2.1 Power State Transitions

The module uses state machines to monitor supply voltage and operating temperature. (See Table 4-5 for threshold details and Figure 4-1 for state machine behavior.)

Power state transitions may occur:

- Automatically, when critical supply voltage or module temperature threshold levels are encountered.
- Under host control, using available AT commands in response to user choices (for example, opting to switch to airplane mode) or operating conditions.

Table 4-5: Power State Thresholds

| Voltage                       |       | Temperature <sup>a</sup> |         |   |
|-------------------------------|-------|--------------------------|---------|---|
| Threshold                     | V     | Threshold                | °C      | Notes   |
| VOLT_HI_CRIT                  | 4.6   | TEMP_HI_CRIT             | 118     | Transition from Normal mode (online) to Low Power mode (offline) when the voltage or temperature rises above the corresponding threshold value.   |
| VOLT_HI_WARN                  | 4.4   | TEMP_HI_WARN             | 100     | When the voltage or temperature is between the corresponding high warning and high critical thresholds, set a warning and remain in the current mode (Normal or Low Power).  Note — If the device is in Normal mode (online) and the temperature warning is set, the module performance may be reduced (Class B temperature range). |
| VOLT_NORM                     | 3.3   | TEMP_NORM                | 70      | Operate in Normal mode (online) while the voltage and temperature are both between their corresponding high and low warning threshold values.   |
| VOLT_LO_WARN                  | 3.135 | TEMP_LO_WARN             | -30     | When the voltage or temperature is between the corresponding low warning and low critical thresholds, set a warning and remain in the current mode (Normal or Low Power).  Note — If the device is in Normal mode (online) and the temperature warning is set, the module performance may be reduced (Class B temperature range).   |
| VOLT_LO_CRIT                  | 2.9   | TEMP_LO_CRIT             | -45     | Transition from Normal mode (online) to Low Power mode (offline) when the voltage or temperature drops below the corresponding threshold value.   |
| MANUAL TRANSITION TO OFF MODE |       | module operating ter     | mperati | rinitiated (manual) power off is recommended when either the supply voltage or the ure is critically low or high. (Note — The host should provide a stable and valid voltage e the voltage does not enter high or low critical ranges.)   |

a. Highest junction temperature among onboard chipsets (PAs, PMIC, XO, SDX55)

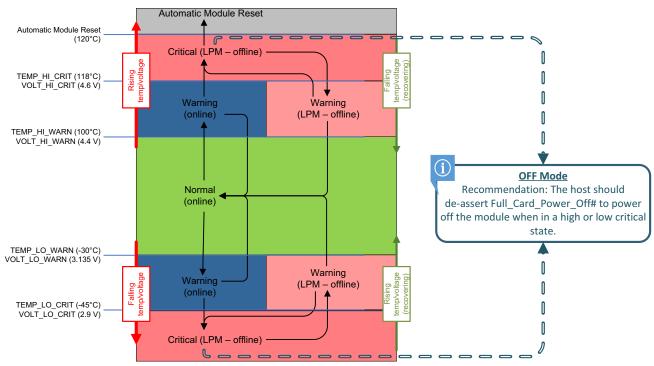


Figure 4-1: Voltage/Temperature Monitoring State Machines

### 4.3 Power Interface

### 4.3.1 Power Ramp-up

On initial power up, inrush current depends on the power supply rise time — turn on time >100 µs is required for < 3 A inrush current.

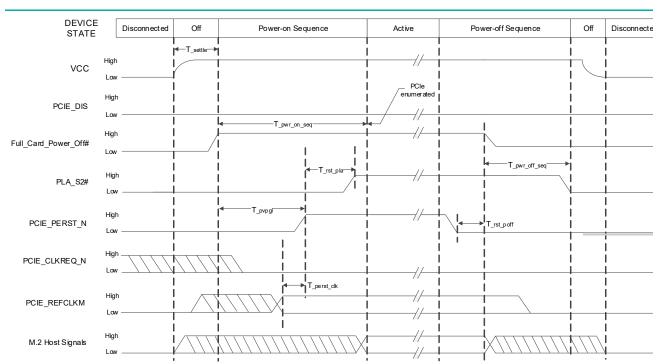
The supply voltage must remain within specified tolerances while this is occurring.

# **4.3.2 Timing**

### 4.3.2.1 Power On/Off Timing for PCle Port

Figure 4-2 describes the timing of PCIe port detection in the power-on/off sequence.

Note: Before reaching the "Active" state, signals on the host port are undefined and signal transitions may occur. This undefined state also applies when the module is in reset mode, during a firmware update, or during the Power-off sequence. The host must consider these undefined signal activities when designing the module interface.



Note: The host must not drive any signals to the module until > 100 ms from the start of the power-on sequence.

Figure 4-2: Power On/Off Timing—PCIe Port

| Table 4-6: PCle Timing | Tabl | e 4 | 4-( | 6: | P | Cle | e T | im | ing |
|------------------------|------|-----|-----|----|---|-----|-----|----|-----|
|------------------------|------|-----|-----|----|---|-----|-----|----|-----|

| Symbol               | Parameter                                    | Min | Тур              | Max | Unit |
|----------------------|--|-----|------------------|-----|------|
| T_settle             | Power on to Power Valid                      | _   | _                | _   | ms   |
| T_pvpgl <sup>a</sup> | Power Valid to PCIE_PERST_N input high       | 50  | _                | _   | ms   |
| T_rst_pla            | PCIE_PERST_N high to PLA_S2# high            | _   | 157              |     | ms   |
| T_rst_poff           | PCIE_PERST_N low to Full_Card_Power_Off# low | 0   | See <sup>b</sup> | _   | S    |
| T_pwr_on_seq         | Power on sequence time                       | _   | 4.5              | 10  | S    |
| T_pwr_off_seq        | Power off sequence time                      | _   | 4.5              | 8   | S    |
| T_perst_clk          | PCIE_REFCLKM stable before PCIE_PERST_N high | 100 | _                | _   | μs   |

a. T\_pvgpl is dependent on the host PCle controller implementation.

Note: Power Valid when all the voltage supply rails have reached their respective Vmin.

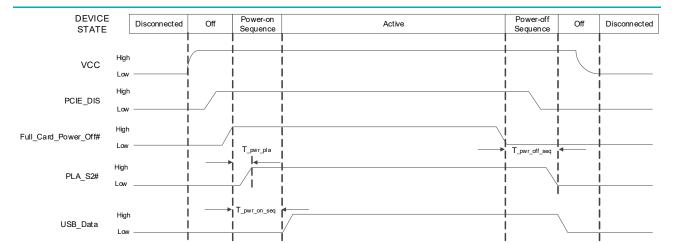
Tsettle is depending on the host power design, (i.e. a typical Adapter with a load capacitance of 330 μF and a 200 mA Soft-Start current limited ramp on the 3.3 V power rail, should settle within 5 ms.)

# 4.3.2.2 Power On/Off Timing for USB Port

Figure 4-3 describes the timing of USB port detection in the power on/off sequence.

b. PCIE\_PERST\_N can be asserted (signal low) any time up to the moment Full\_Card\_Power\_Off# is asserted.

Note: Before reaching the "Active" state, signals on the host port are undefined and signal transitions may occur. This undefined state also applies when the module is in reset mode, during a firmware update, or during the Power-off sequence. The host must consider these undefined signal activities when designing the module interface.



Note: The host must not drive any signals to the module until > 100 ms from the start of the power-on sequence.

Figure 4-3: Signal Timing (Full\_Card\_Power\_Off#, and USB Enumeration)

Table 4-7: USB Power-On/Off Timing Parameters

| Symbol        | Parameter                | Min | Тур  | Max | Unit |
|---------------|--------------------------|-----|------|-----|------|
| T_pwr_on_seq  | Power on sequence time   | _   | 14.7 | 35  | S    |
| T_pwr_pla     | Power on to PLA_S2# high | _   | 250  | 300 | ms   |
| T_pwr_off_seq | Power off sequence time  | _   | 4.5  | 8   | S    |

# 4.3.2.3 Reset Timing

M.2 Host Signals

To reset the module, see Table 2-8 on page 36 for RESET# signal usage instructions.

### 4.3.2.4 Required Shutdown Sequence

**Important:** To avoid causing issues with the file system, follow this shutdown sequence. Note that this sequence works only on a module that has completely booted up.

To safely power off the module:

1. Drive Full\_Card\_Power\_Off# low to trigger the firmware to safely power off.

Note: The power off process finishes within ~8 seconds.

- 2. Wait until PLA S2# is asserted to low.
- 3. Remove power.

# 4.3.3 Power Supply Noise

Noise in the power supply can lead to noise in the RF signal.

The power supply ripple limit for the module is no more than 100 mVp-p, 1–100 kHz. This limit includes voltage ripple due to transmitter burst activity.

Additional decoupling capacitors can be added to the main VCC line to filter noise into the device.

## 4.3.4 SED (Smart Error Detection)

The module uses a form of SED to track premature modem resets.

- Module tracks consecutive resets occurring soon after power-on.
- After a sixth consecutive reset, the module waits in boot-and-hold mode for a firmware download to resolve the power-cycle problem.

# 5: Software

Mobile Broadband Packages are available for EM91 modules on the specific device pages at source.sierrawireless.com.

EM91 modules support USB and PCIe as physical host interfaces.

These packages are software suites that include:

- Device drivers
- SDK
- Tools and documentation (Firmware Logging and troubleshooting utilities, Developer's guide)

For PCIe development resources (available subject to license agreement), please contact your Sierra Wireless representative.

# 6: Mechanical and Environmental Specifications

EM91 modules comply with the mechanical and environmental specifications in Table 6-1. Final product conformance to these specifications depends on the OEM device implementation.

Table 6-1: Mechanical and Environmental Specifications

|  | Mode                                   | Details  |  |  |  |
|--|--|--|--|--|--|
|  | Operational Class A                    | -30°C to +70°C — 3GPP compliant, with appropriate heatsinking, when using a suitable external SIM (Note: The onboard eSIM is operational between -25°C to +85°C.)  |  |  |  |
| Ambient temperature                            | Operational Class B                    | -40°C to +85°C, with appropriate heatsinking — non-3GPP compliant (reduced operating parameters required), when using a suitable external SIM (Note: The onboard eSIM is operational between -25°C to +85°C.)                          |  |  |  |
| Humidity Test 15 minutes Idle / 15 minutes Off |  | Test temperature: 85°C<br>Relative humidity: 85%<br>Stress duration: 10 days   |  |  |  |
| Thermal Shock Test                             | Non-operational                        | Test temperature: -40°C to +85°C Temperature transition time: < 30 seconds Dwell time: 10 minutes Stress duration: 300 cycles  |  |  |  |
| High Temperature Operating<br>Life Test        | 45 minutes Max TX /<br>15 minutes Idle | Temperature: 85 ° C<br>Stress duration: 20 days (480 cycles)   |  |  |  |
| Low Temperature Cold Start<br>Test             | 30 minutes Off /<br>5 minutes Idle     | Test temperature: -40°C<br>Stress duration: 5 days   |  |  |  |
| Mechanical Shock                               | Non-operational                        | Waveform: Half sine Peak acceleration: 30 g Shock duration: 6 ms Number of shocks: 3 Shock direction: ±X, ±Y, ±Z Stress duration: 1 day  |  |  |  |
| Drop   | Non-operational                        | Number of drops: 1 drop per direction (±X, ±Y, ±Z), 6 directions—total 6 drops per module (1 round)  Surface type: Unprotected drops onto a surface that meets the test standard requirement  Drop height: 1 m  Stress duration: 1 day |  |  |  |

Table 6-1: Mechanical and Environmental Specifications (Continued)

|   | Mode            | Details   |
|---|-----------------|---|
| Electrostatic Discharge (See<br>Electrostatic Discharge (ESD) | Operational     | The LTE/Sub-6 antenna ports comply with the IEC 61000-4-2 standard:  Electrostatic discharge immunity: Test Level 3  Air discharge: ±8 kV  Contact discharge: ±6 kV                     |
| on page 72.)  | Non-operational | The host connector interface (M.2) and mmWave IF ports (EM9190 only) comply with the following standard only:  Minimum ±500 V Human Body Model (JS-001-2017)                            |
| Form factor   |                 | M.2 Form Factor (Conforms to width specification)   |
| Dimensions  |                 | Length: 52±0.15 mm (max, exclude de-panel burr) Width: 30±0.15 mm (max, exclude de-panel burr) Thickness: 2.38 mm (max):  Above PCB—1.50 mm (max)  PCB—0.88 mm (max)  Weight: 9 g (max) |
| MTBF  |                 | 87.01 years Temperature: 25°C   |

# **6.1 Device Views**

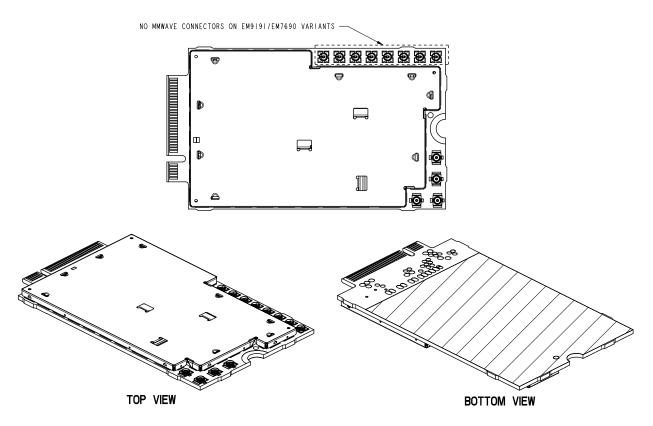


Figure 6-1: Top View and Bottom View

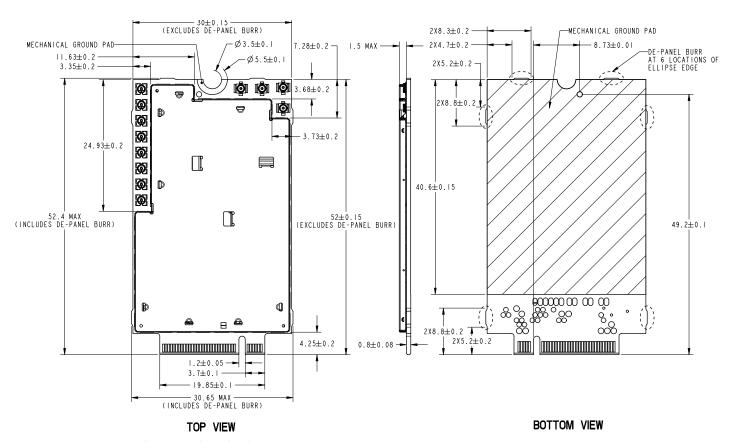


Figure 6-2: Dimensioned View — Mechanical Outline

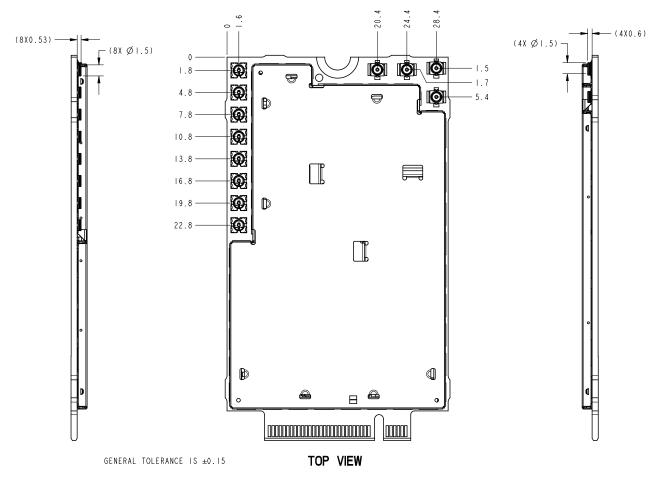
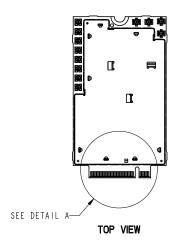
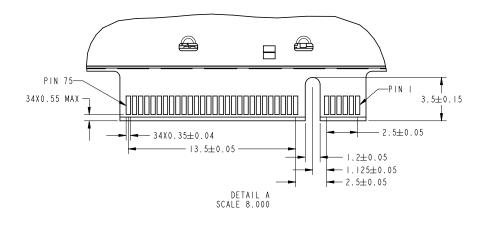
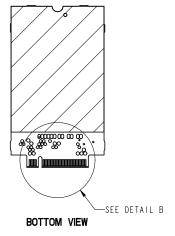


Figure 6-3: Dimensioned View — Connector Locations







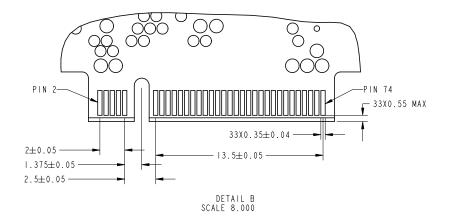


Figure 6-4: Dimensioned View — Pin-out

# 6.2 Product Marking (Labeling)



Figure 6-5: Unit Product Marking Example—Laser-etched, Typical Representation (Contents vary by SKU.)

The EM91 module's product marking is laser-etched and may contain:

- Sierra Wireless logo and product name
- IMEI number in Data Matrix barcode format
- SKU number (when required)
- Factory Serial Number (FSN) in alphanumeric format
- Manufacturing date code (incorporated into FSN)
- Licensed vendor logo
- Certification marks/details
- CPN
- Barcodes
- Manufacture location

Note: EM91 modules support OEM partner-specific label requirements.

# 6.3 Electrostatic Discharge (ESD)

The OEM is responsible for ensuring that the EM91 module's host interface pins are not exposed to ESD during handling or normal operation. (See Table 6-1 on page 66 for specifications.)

ESD protection is highly recommended for the SIM connector at the point where the contacts are exposed, and for any other signals from the host interface that would be subjected to ESD by the user of the product. (The device includes ESD protection on the Sub-6G antenna ports.)

### 6.4 Thermal Considerations

Embedded modules can generate significant amounts of heat that must be dissipated in the host device for safety and performance reasons. Figure 6-6 and Figure 6-7 display the location of heat sources

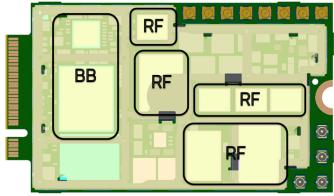


Figure 6-6: Shield Locations (Top View)

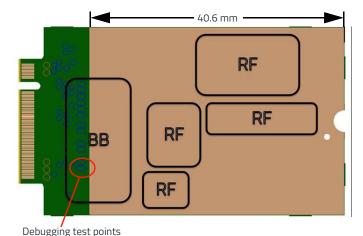


Figure 6-7: Copper Pad Location on Bottom Side of Module

Specific areas requiring heat dissipation are shown in Figure 6-7:

- RF Bottom face of module near RF connectors. Likely to be the hottest area.
- Baseband Bottom face of module, below the baseband area.

#### To enhance heat dissipation:

- Sierra Wireless recommends adding a heat sink that mounts the module to the main PCB or metal chassis.
  Important A non-conductive thermal compound or pad <u>must</u> be used between the module and the heat sink.
  Note Sierra Wireless recommends that test points TP328 and TP329 (see Figure 6-7) remain accessible for Sierra Wireless to assist in system debugging. Make sure the test points are not shorted to anything.
- Maximize airflow over/around the module.
- Locate the module away from other hot components.
- Module ground holes must be used to attach (ground) the device to the main PCB ground or a metal chassis.
- You may also need active cooling to pull heat away from the module.

Note: Adequate dissipation of heat is necessary to ensure that the module functions properly. Refer to [3] EM9190 Thermal Application Note (Doc# 2174257) for more details.

# 6.5 Module Integration Testing

When testing your integration design:

- Test to your worst case operating environment conditions (temperature and voltage)
- Test using worst case operation
- Monitor temperature at all shield locations. Attach thermocouples to the areas indicated in Figure 6-6 on page 73 (RF, Baseband).

Note: Make sure that your system design provides sufficient cooling for the module.

# 6.6 Secure Boot/Secure Debug

EM91 modules incorporate the following permanently enabled features to enhance device security:

- Secure Boot Ensures only firmware images signed by Sierra Wireless can be loaded and run on EM91 modules; unauthorized code cannot be loaded to the module.
   Specifically, Secure Boot applies to the following firmware components: system boot loader, carrier configuration, and telecom FW.
- Secure Debug Disables debug features such as RAM dump collection and JTAG access to the module.

# 7: Regulatory Compliance and Industry Certifications

This chapter describes the current certification status of the EM9190 and EM9191 (hereinafter collectively referred to as "EM919X") and EM7690. Certifications in other countries may be attained upon customer request—contact your Sierra Wireless account representative for details.

Additional testing and certification may be required for the host product with an embedded EM919X module and are the responsibility of the OEM. Sierra Wireless offers professional services-based assistance to OEMs with the testing and certification process, if required.

## 7.1 Regulatory Compliance

The EM919X/EM7690 module meets the requirements of the following regulatory bodies and regulations, where applicable:

- Federal Communications Commission (FCC) of the United States
- Innovation, Science and Economic Development Canada (ISED)
- The National Communications Commission (NCC) of Taiwan, Republic of China
- Radio Equipment Directive (RED) of the European Union

# 7.1.1 Important Compliance Information for the United States and Canada

The EM919X/EM7690 module has been granted modular approval for mobile applications under:

- FM919X-
  - FCC ID: N7NEM91
  - · IC: 2417C-EM91
- EM7690:
  - FCC ID: N7NFM76
  - · IC: 2417C-EM76

Integrators may use the EM919X/EM7690 module in their host products without additional FCC/ISED certification if they meet the following conditions. Otherwise, additional FCC/ISED approvals must be obtained.

- 1. At least 20 cm separation distance between the antenna and the user's body must be maintained at all times.
- 2. To comply with FCC/ISED regulations limiting both maximum RF output power and human exposure to RF radiation, the maximum antenna gain including cable loss in a mobile-only exposure condition must not exceed the limits stipulated in Table 7-1.
- **3.** The EM919X/EM7690 module may transmit simultaneously with other collocated radio transmitters within a host product, provided the following conditions are met:
  - Each collocated radio transmitter has been certified by FCC/ISED for mobile application.
  - At least 20 cm separation distance between the antennas of the collocated transmitters and the user's body must be maintained at all times.
  - · The radiated power of a collocated transmitter must not exceed the EIRP limit stipulated in Table 7-1.

Table 7-1: Antenna Gain and Collocated Radio Transmitter Specifications

|        |  | Tx Freq Range |      | Mary Care divisted           | Maximum Antenna Gain (dBi) |            |
|--------|--|---------------|------|------------------------------|----------------------------|------------|
| Device | Operating Mode                           |               | Hz)  | Max Conducted<br>Power (dBm) | Standalone                 | Collocated |
|        | WCDMA Band 2                             | 1850          | 1910 | 24.5                         | 8.5                        | 8.0        |
|        | WCDMA Band 4                             | 1710          | 1755 | 24.5                         | 5.5                        | 5.5        |
|        | WCDMA Band 5                             | 824           | 849  | 24.5                         | 6.0                        | 5.5        |
|        | LTE B2                                   | 1850          | 1910 | 24                           | 8.5                        | 8.0        |
|        | LTE B4                                   | 1710          | 1755 | 24                           | 5.5                        | 5.5        |
|        | LTE B5                                   | 824           | 849  | 24                           | 6.0                        | 6.0        |
|        | LTE B7                                   | 2500          | 2570 | 24.8 <sup>a</sup>            | 8.0                        | 8.0        |
|        | LTE B12                                  | 699           | 716  | 24                           | 6.0                        | 5.5        |
|        | LTE B13                                  | 777           | 787  | 24                           | 6.0                        | 5.5        |
|        | LTE B14                                  | 788           | 798  | 24                           | 6.0                        | 6.0        |
|        | LTE B17                                  | 704           | 716  | 24                           | 6.0                        | 5.5        |
| EM919x | LTE B25                                  | 1850          | 1915 | 24                           | 8.5                        | 8.0        |
| EM7690 | LTE B26                                  | 814           | 849  | 24                           | 6.0                        | 6.0        |
|        | LTE B30*                                 | 2305          | 2315 | 24                           | 0.0                        | 0.0        |
|        | LTE B41                                  | 2496          | 2690 | 24.8 <sup>a</sup>            | 7.0                        | 7.0        |
|        | LTE B41-HPUE                             | 2496          | 2690 | 26                           | 7.0                        | 7.0        |
|        | LTE B42 <sup>b</sup>                     | 3450          | 3550 | 24.8                         | 5.0                        | 5.0        |
|        | LTE B42 <sup>c</sup> /B43 <sup>c</sup>   | 3450          | 3650 | 24.8 <sup>a</sup>            | -1.8                       | -1.8       |
|        | LTE B48 <sup>b</sup> **                  | 3550          | 3700 | 24.8 <sup>a</sup>            | -1.8                       | -1.8       |
|        | LTE B48 <sup>c</sup>                     | 3550          | 3700 | 24.8 <sup>a</sup>            | 5.2                        | 5.2        |
|        | LTE B66                                  | 1710          | 1780 | 24                           | 6.0                        | 6.0        |
|        | LTE B71                                  | 663           | 698  | 24                           | 6.0                        | 5.5        |
|        | 5G NR n2                                 | 1850          | 1910 | 24.5                         | 8.5                        | 8.0        |
|        | 5G NR n5                                 | 824           | 849  | 24.5                         | 6.0                        | 5.5        |
|        | 5G NR n7                                 | 2500          | 2570 | 24.5                         | 8.0                        | 8.0        |
|        | 5G NR n12                                | 699           | 716  | 24.5                         | 6.0                        | 5.0        |
|        | 5G NR n25                                | 1850          | 1915 | 24.5                         | 8.5                        | 8.0        |
|        | 5G NR n41                                | 2496          | 2690 | 24.5                         | 7.0                        | 7.0        |
| EM919x | 5G NR n48 <sup>b</sup>                   | 3550          | 3700 | 24.5                         | -1.8                       | -1.8       |
|        | 5G NR n48 <sup>c **</sup>                | 3550          | 3700 | 24.5                         | 5.5                        | 5.5        |
|        | 5G NR n66                                | 1710          | 1780 | 24.5                         | 5.5                        | 5.5        |
|        | 5G NR n71                                | 663           | 698  | 24.5                         | 5.5                        | 5.0        |
|        | EC ND 277 0/270b                         | 3450          | 3550 | 7/ F                         | 5.5                        | E E        |
|        | 5G NR n77 <sup>b</sup> /n78 <sup>b</sup> | 3700          | 3980 | _ 24.5                       |                            | 5.5        |
|        | 5G NR n77 <sup>c</sup> /n78 <sup>c</sup> | 3450          | 3980 | 24.5                         | 5.5                        | 5.5        |

Table 7-1: Antenna Gain and Collocated Radio Transmitter Specifications (Continued)

|              |                | Tx Freq Range<br>(MHz) |      | Max Conducted | Maximum Antenna Gain (dBi) |            |
|--------------|----------------|------------------------|------|---------------|----------------------------|------------|
| Device       | Operating Mode |                        |      | Power (dBm)   | Standalone                 | Collocated |
|              |                |                        |      | Max           | kimum EIRP (dBm)           |            |
| Collocated   | WLAN 2.4 GHz   | 2400                   | 2500 |               | 25.0                       |            |
| transmitters | WLAN 5 GHz     | 5150                   | 5850 |               | 28.0                       |            |
|              | Bluetooth      | 2400                   | 2500 |               | 22.0                       |            |

- a. Includes 0.8 dB offset from single-cell tolerance (Table 3-12 on page 54) for UL CA
- b. USA only
- c. Canada only

\*Important: The FCC and ISED have a strict EIRP limit in LTE Band 30 for mobile and portable stations in order to protect adjacent satellite radio, aeronautical mobile telemetry, and deep space network operations. Mobile and portable stations must not have antenna gain exceeding 0 dBi in LTE Band 30. Additionally, both the FCC and ISED prohibit the use of external vehicle-mounted antennas for mobile and portable stations in this band.

Fixed stations are generally subject to higher EIRP limits. EM919X/EM7690 modules used as fixed subscriber stations in Canada may use antennas with higher gain in LTE Band 30, subject to other operating conditions stipulated in RSS-195 and SRSP-516. EM919X/EM7690 modules used as fixed customer premises equipment (CPE) stations in the United States may use antennas with higher gain in LTE Band 30, subject to other operating conditions stipulated in FCC Part 27.

Mobile carriers often have limits on total radiated power (TRP), which requires an efficient antenna. The host product with an embedded module must output sufficient power to meet the TRP requirement but not too much to exceed the FCC's and ISED's EIRP limit. If you need assistance in meeting this requirement, please contact Sierra Wireless.

\*Important: Airborne operations in LTE Band 48 are prohibited.

- **4.** A label must be affixed to the outside of the host product into which the EM919X/EM7690 module is incorporated, with a statement similar to the following:
  - EM919X—This device contains FCC ID: N7NEM91, IC: 2417-EM91.
  - EM7690—This device contains FCC ID: N7NEM76, IC: 2417-EM76.
- **5.** A user manual with the host product must clearly indicate the operating requirements and conditions that must be observed to ensure compliance with current FCC/ISED RF exposure guidelines.

**Note:** Host product manufacturers are responsible for the overall compliance of the host products including, where applicable, all additional equipment authorization and testing not covered by the modular approval (e.g., unintentional radiator FCC Part 15 Subpart B requirements, ISED's Interference-Causing Equipment Standards, and RF exposure requirements for host products intended for use within 20 cm of the user's body.)

### 7.2 Industry Certifications

The EM919X/EM7690 module complies with the mandatory requirements described in the following standards. The exact set of requirements supported is network operator-dependent.

Table 7-2: Standards Compliance

| Technology         | Standards       |
|--------------------|-----------------|
| 5G NR <sup>a</sup> | 3GPP Release 15 |
| LTE                | 3GPP Release 15 |
| WCDMA              | 3GPP Release 9  |

a. EM919x only

The following industry certifications have been obtained, where applicable:

- GCF
- PTCRB



# A: Antenna Specification

This appendix describes recommended electrical performance criteria for Sub-6G, GNSS, and mmWave antennas used with Sierra Wireless embedded modules.

The performance specifications described in this section are valid while antennas are mounted in the host device with antenna feed cables routed in their final application configuration.

Note: Antennas should be designed before the industrial design is finished to make sure that the best antennas can be developed

# A.1 Recommended Sub-6 Antenna Specifications

Table A-1: Sub-6 Antenna Requirements<sup>a</sup>

| Parameter                 | Requirements  | Comments  |  |
|---------------------------|---|---|--|
| Antenna system            | <ul> <li>NR/LTE:         External multi-band 4×4 DL MIMO         antenna system — MAIN, AUX, MIMO1,         MIMO2</li> <li>3G:         External multi-band antenna system         with diversity — MAIN, AUX</li> </ul> | If AUX or MIMO2 includes GNSS, it must also satisfy requirements in Table A-2 on page 81.   |  |
| Operating bands           | <ul> <li>MAIN — All supported Tx and Rx frequency bands.</li> <li>AUX, MIMO1, MIMO2 — All supported Rx frequency bands, plus GNSS frequency bands if AUX is used in shared Diversity/MIMO/GNSS mode.</li> </ul>         |   |  |
| VSWR                      | <ul><li>MAIN, AUX:</li><li>&lt; 2:1 (recommended)</li><li>&lt; 3:1 (worst case)</li></ul>   | On all bands including band edges   |  |
| Total radiated efficiency | > 50% on all bands  | <ul> <li>Measured at the RF connector.</li> <li>Includes mismatch losses, losses in the matching circuit, and antenna losses, excluding cable loss.</li> <li>Sierra Wireless recommends using antenna efficiency as the primary parameter for evaluating the antenna system.</li> <li>Peak gain is not a good indication of antenna performance when integrated with a host device (the antenna does not provide omni-directional gain patterns). Peak gain can be affected by antenna size, location, design type, etc. — the antenna gain patterns remain fixed unless one or more of these parameters change.</li> </ul> |  |
| Radiation patterns        | Nominally omni-directional radiation pattern in azimuth plane.  |   |  |

Table A-1: Sub-6 Antenna Requirements<sup>a</sup> (Continued)

| Parameter  | Requirements  | Comments   |
|--|---|--|
| Envelope correlation coefficient   | Between MAIN and AUX: <ul> <li>&lt; 0.5 on Rx bands below 960 MHz</li> <li>&lt; 0.2 on Rx bands above 1.4 GHz</li> </ul>  |  |
| MAIN (MEG1), AUX (MEG2), MIMO1 (MEG3), MIMO2 (MEG4):  ■ ≥ -3 dBi   |   |  |
| Mean Effective Gain Imbalance $\frac{MEGx}{MEGy}$  | Between any two antennas: <ul> <li>&lt; 2 dB for MIMO operation</li> <li>&lt; 6 dB for diversity operation</li> </ul>     |  |
| Must not exceed antenna gains due to RF exposure and ERP/EIRP limits, as listed in the module's FCC grant. |   | See Important Compliance Information for the United States and Canada on page 75.  |
| Isolation  | <ul> <li>B41: &gt;20 dB for MAIN and MIMO2</li> <li>All antennas for all other bands: &gt;10 dB</li> </ul>                | <ul> <li>If antennas can be moved, test isolation for all positions.</li> <li>Make sure all other wireless devices (Bluetooth or WLAN antennas, etc.) are turned OFF to avoid interference.</li> </ul>   |
| Maximum input power at antenna port  | <ul> <li>MAIN — 10 dBm</li> <li>AUX — 10 dBm (*0 dBm)</li> <li>MIMO1 — 10 dBm</li> <li>MIMO2 — 10 dBm (*0 dBm)</li> </ul> | *Important: GPS inband signals on AUX and MIMO2 must be < 0 dBm to avoid damaging LNAs.  |
| Power handling   | ■ >1W   | <ul> <li>Measure power endurance over 4 hours (estimated talk time) using a 1 W CW signal — set the CW test signal frequency to the middle of each supporting Tx band.</li> <li>Visually inspect device to ensure there is no damage to the antenna structure and matching components.</li> <li>VSWR/TIS/TRP measurements taken before and after this test must show similar results.</li> </ul> |

a. These worst-case VSWR figures for the transmitter bands may not guarantee RSE levels to be within regulatory limits. The device alone meets all regulatory emissions limits when tested into a cabled (conducted) 50 Ω system. With antenna designs with up to 2.5:1 VSWR or worse, the radiated emissions could exceed limits. The antenna system may need to be tuned in order to meet the RSE limits as the complex match between the module and antenna can cause unwanted levels of emissions. Tuning may include antenna pattern changes, phase/delay adjustment, and passive component matching. Examples of the application test limits would be included in FCC Part 22, Part 24 and Part 27,test case 4.2.2 for WCDMA (ETSI EN 301 908-1), where applicable.

# A.2 Recommended GNSS Antenna Specifications

Table A-2: GNSS Antenna Requirements

| Parameter  | Requirements   | Comments  |
|--|--|---|
| Frequency range  | <ul> <li>Wide-band GNSS:         1559–1606 MHz recommended</li> <li>Narrow-band GPS:         1575.42 MHz ±2 MHz minimum</li> <li>Narrow-band Galileo:         1575.42 MHz ±2 MHz minimum</li> <li>Narrow-band BeiDou:         1561.098 MHz ±2 MHz minimum</li> <li>Narrow-band GLONASS:         1601.72 MHz ±4.2 MHz minimum</li> <li>Narrow-band QZSS         1575.42 MHz ±2 MHz minimum</li> </ul> |   |
| Field of view (FOV)  | <ul> <li>Omni-directional in azimuth</li> <li>-45° to +90° in elevation</li> </ul>   |   |
| Polarization<br>(average Gv/Gh)  | > 0 dB   | Vertical linear polarization is sufficient.   |
| Free space average gain<br>(Gv+Gh) over FOV  | > -6 dBi (preferably > -3 dBi)   | Gv and Gh are measured and averaged over -45° to +90° in elevation, and ±180° in azimuth. |
| <ul> <li>Maximum gain and uniform coverage in the high elevation angle and zenith.</li> <li>Gain in azimuth plane is not desired.</li> </ul> |  |   |
| Average 3D gain  | > -5 dBi   |   |
| Isolation between GNSS<br>and WWAN Tx (MAIN and<br>AUX)  | > 15 dB in all uplink bands and GNSS Rx bands  |   |
| Typical VSWR   | < 2.5:1  |   |
| Polarization  Any other than LHCP (left-hand circular polarized) is acceptable.  |  |   |

Note: GNSS active antenna is forbidden to use.

### A.3 Sub-6 Antenna Tests

The following guidelines apply to the requirements described in Table A-1 on page 79 and Table A-2 on page 81:

- Perform electrical measurements at room temperature (+20°C to +26°C) unless otherwise specified
- For the MAIN and AUX (diversity) antennas, make sure the antennas (including contact device, coaxial cable, connectors, and matching circuit with no more than six components, if required) have nominal impedances of 50 Ω across supported frequency bands.

- All tests (except isolation/correlation coefficient) Test the MAIN or AUX antenna with the other antenna terminated.
- Any metallic part of the antenna system that is exposed to the outside environment needs to meet the electrostatic discharge tests per IEC61000-4-2 (conducted discharge +8 kV).
- The functional requirements of the antenna system are tested and verified while the embedded module's antenna is integrated in the host device.

Note: Additional testing, including active performance tests, mechanical, and accelerated life tests can be discussed with Sierra Wireless' engineering services. Contact your Sierra Wireless representative for assistance.

#### A.4 mmWave Antennas

Note: For EM9190 only.

The mmWave-capable EM9190 module is available in low-power (connectorized) antenna module SKU configurations or high-power (soldered down) antenna module SKU configurations. The EM9190 module can support up to four antenna modules.

Table A-3 describes the primary mechanical and functional differences between low and high power mmWave antenna modules. For more information, refer to [6] EM9190 mmWave Design Guidelines (Doc# 2174276).

| Table A-3: | Low Power | /High Powe | r mmWave | <b>Antenna</b> | Comparison |
|------------|-----------|------------|----------|----------------|------------|
|            |           |            |          |                |            |

| Parameter Low Power Modules        |                                     | High Power Modules                                     |
|------------------------------------|-------------------------------------|--|
| Module type                        | QTM525                              | QTM527   |
| Typical applications               | Laptops<br>Tablets<br>Home gateways | CPE (outdoor) products                                 |
| Simultaneously active              | No. Only one active at a time.      | Yes. All four antennas work together for active power. |
| EIRP                               | 23 dBm                              | 45 dBm   |
| Connection method to EM9190 module | 10-pin connectorized                | Solder down  |
| Module footprint area              | ~100 mm <sup>2</sup>                | ~400 mm <sup>2</sup>                                   |

### A.4.1 Low Power mmWave Antenna Modules

When integrating an EM9190 with QTM525 low power mmWave antenna modules on a host platform:

- The OEM/ODM provides 1–4 antenna modules on the platform.
- The customer uses two MHF7S IF cables to connect each antenna module to the appropriate mmWave connectors on the EM9190.
- The customer provides external 3.8 V supply to power the antenna modules.
- Non-RF logic signals (QTMx\_PON, QTM\_IO\_1.9V) are supplied via the EM9190 M.2 interface and routed to the antenna modules via one of the following methods:

- Recommended Direct board-to-board connection (i.e. direct connections on PCB from M.2 connector to antenna modules)
- Alternate FPC (i.e. FPC connections from host platform PCB to antenna modules mounted on separate adapter boards)

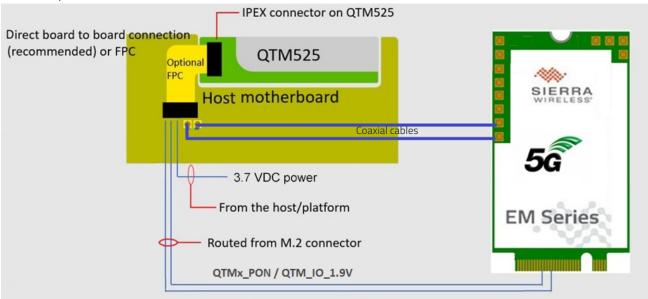


Figure A-1: Example—Connecting Low Power mmWave Antenna Module to Host Platform

### A.4.2 High Power mmWave Antenna Modules

When integrating an EM9190 with QTM527 high power mmWave antenna modules on a host platform:

- The OEM/ODM provides 4 antenna modules in a 2x2 array on the platform.
- The antenna module type (e.g. QTM527-1 or QTM527-2) chosen by the customer depends on the bands to be provided by the host platform.
- The customer uses two MHF7S IF cables to connect each antenna module to the appropriate mmWave connectors on the EM9190.
- The customer provides external 3.8 V supply to power the antenna modules. Each antenna module is independently powered, and multiple antenna modules can be used simultaneously for increased power.

For details, refer to [6] EM9190 mmWave Design Guidelines (Doc# 2174276).

# **B: Thermal Testing**

### **B.1 Worst Case Testing**

Sierra Wireless recommends that customers identify realistic worst-case conditions for their platforms and perform appropriate thermal testing.

#### For example:

- If the device has very good throughput, it is likely near a tower so will not have to transmit at maximum Tx output power.
- If the device is transmitting at maximum Tx power, it is likely not near a tower and will not reach maximum throughput rates.
- Networks usually are sharing capacity among many users, so no single user is likely to reach maximum throughput rates for any significant length of time.
- If the device is transmitting at maximum throughput, it will likely do so for a limited time to limit the amount of data usage consumed from their data plan.

### **B.2 Thermal Testing Process**

To perform thermal testing of the module:

- 1. Mount the module in its designed location on the platform.
- 2. Provide the same amount of airflow as will be experienced in your platform.
- **3.** Set the platform's ambient to the higher limit of the specification and observe the junction temperature ramp. (Use **AT!PCTEMP?**)
- 4. Set up a call with the use case for the platform (throughput rate, output power, duty cycle) on the worst-case band.
- **5.** Observe the ramp in junction temperature due to the call, and confirm whether the overall system performance still meets customer requirements.
- **6.** Use **AT!TMSTATUS?** to check the module's thermal mitigation status (refer to [1] Sierra Wireless EM9 Series AT Command Reference (Doc# 41113480) for details).
- 7. Increase the platform's ambient temperature to determine the margin that exists over the desired temperature specifications as subsequent mitigation methods activate (e.g. UL data rate throttled, DL throughput throttled (third and second CA dropped), UL power reduced, Emergency Service).

Note: Refer to [3] EM9190 Thermal Application Note (Doc# 2174257) for more details.



# **C: Production Testing**

Note: All Sierra Wireless embedded modules are factory-tested to ensure they conform to published product specifications.

Developers of OEM devices integrating Sierra Wireless embedded modules should include a series of test phases in their manufacturing process to make sure their devices work properly with the embedded modules. For more information, refer to [5] EM919X Customer Production Test Mode (Doc# 41113679).

Sierra Wireless offers optional professional services-based assistance to OEMs with regulatory approvals.



# D: Packaging

Sierra Wireless Embedded Modules are shipped in sealed boxes. The standard packaging (see Figure D-1), contains a single tray with a capacity of 100 modules. (Note that some SKUs may have custom packaging — contact Sierra Wireless for SKU-specific details.)

In the standard packaging, Embedded Modules are inserted, system connector first, into the bottom portion (T1) of a two-part tray. all facing the same direction. This allows the top edge of each Embedded Module to contact the top of the triangular features in the top portion (T2) of the tray (Detail A).

The top and bottom portions of the tray snap together at the four connection points.

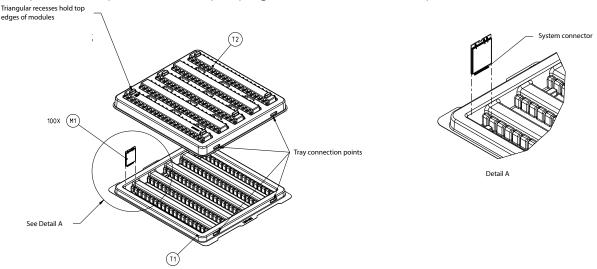


Figure D-1: Device Placement in Module Tray

The tray cover is secured to the tray base with ESD-safe tape (EP1) at the locations indicated. The tray is placed in a manufacturing box(B1), sealed with a security tape (P1), a manufacturing label (L3) is placed on the bottom-right corner, above the security tape, and if required a label (L4) is applied beside the manufacturing label. (See Figure D-2.)

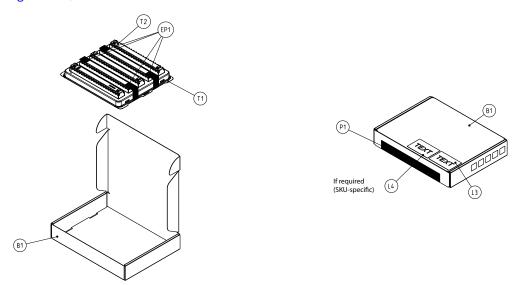


Figure D-2: Shipping Package



# E: Design Checklist

This chapter provides a summary of the design considerations mentioned throughout this guide. This includes items relating to the power interface, RF integration, thermal considerations, cabling issues, and so on.

Note: This is NOT an exhaustive list of design considerations. It is expected that you will employ good design practices and engineering principles in your integration.

Table E-1: Hardware Integration Design Considerations

| Suggestion  | Section where discussed                                    |  |  |  |
|---|--|--|--|--|
| Component Placement   |  |  |  |  |
| If an ESD suppressor is not used on the host device, allow space on the SIM connector for series resistors in layout. (Up to 100 $\Omega$ may be used depending on ESD testing requirements).   | SIM Implementation on page 33                              |  |  |  |
| Minimize RF cable losses as these affect performance values listed in product specification documents.  | RF Connections on page 43                                  |  |  |  |
| Antennas  |  |  |  |  |
| Match the module/antenna coax connections to 50 $\Omega$ — mismatched antenna impedance and cable loss negatively affect RF performance.  | RF Connections on page 43                                  |  |  |  |
| If installing UMTS and CDMA modules in the same device, consider using separate antennas for maximum performance.   | Sub-6G Antennas and Cabling on page 43                     |  |  |  |
| Power   |  |  |  |  |
| Make sure the power supply can handle the maximum current specified for the module type.  | Power Consumption on page 56                               |  |  |  |
| Limit the total impedance of VCC and GND connections to the SIM at the connector to less than 1 $\Omega$ (including any trace impedance and lumped element components — inductors, filters, etc.). All other lines must have a trace impedance less than 2 $\Omega$ . |  |  |  |  |
| Decouple the VCC line close to the SIM socket. The longer the trace length (impedance) from socket to module, the greater the capacitance requirement to meet compliance tests.   |  |  |  |  |
| PCB Signal Routing  |  |  |  |  |
| USB — Route the USB interface signals over 90 $\Omega$ differential lines on the PCB.   |  |  |  |  |
| PCle 3.0 — Route the data and clock differential pairs over 90 $\Omega$ differential lines on the PCB.  |  |  |  |  |
| I2C port—If supported, route these signals away from noise-sensitive signals on the PCB.  |  |  |  |  |
| PCM port — If supported, route these signals away from noise-sensitive signals on the PCB.  |  |  |  |  |
| EMI/ESD   |  |  |  |  |
| Investigate sources of localized interference early in the design cycle.  | Methods to Mitigate Decreased<br>Rx Performance on page 45 |  |  |  |
| Provide ESD protection for the SIM connector at the exposed contact point (in particular, the CLK, VCC, IO, and RESET# lines).  | SIM Implementation on page 33                              |  |  |  |
| Keep very low capacitance traces on the UIM_DATA and UIM_CLK signals.   |  |  |  |  |

Table E-1: Hardware Integration Design Considerations (Continued)

| Suggestion   | Section where discussed       |  |
|--|-------------------------------|--|
| To minimize noise leakage, establish a very good ground connection between the module and host.  | Ground Connection on page 44  |  |
| Route cables away from noise sources (for example, power supplies, LCD assemblies, etc.).  |                               |  |
| Shield high RF-emitting components of the host device (for example, main processor, parallel bus, etc.).                               | Methods to Mitigate Decreased |  |
| Use discrete filtering on low frequency lines to filter out unwanted high-order harmonic energy.                                       | Rx Performance on page 45     |  |
| Use multi-layer PCBs to form shielding layers around high-speed clock traces.  |                               |  |
| Thermal  |                               |  |
| Test to worst case operating conditions — temperature, voltage, and operation mode (transmitter on 100% duty cycle, maximum power).    | Thermal Considerations on     |  |
| Use appropriate techniques to reduce module temperatures (for example, airflow, heat sinks, heat-relief tape, module placement, etc.). |                               |  |

### F: References

### F.1 Sierra Wireless Documents

Sierra Wireless documents are available from source.sierrawireless.com, or on request (subject to license agreements or NDAs) from your Sierra Wireless representative.

#### Sierra Wireless Documents on the Source

The following documents are available from source.sierrawireless.com:

- [1] Sierra Wireless EM9 Series AT Command Reference (Doc# 41113480)
- [2] Sierra Wireless EM919x/EM7690 Development Kit User Guide (Doc# 41113875)
- [3] EM9190 Thermal Application Note (Doc# 2174257)
- [4] EM919x/EM7690 Thermal Mitigation Application Note (Doc# 2174267)
- [5] EM919X Customer Production Test Mode (Doc# 41113679)
- [6] EM9190 mmWave Design Guidelines (Doc# 2174276)
- [7] EM919X 5G NR Peak Throughput (Doc# 2174277)
- [8] EM9190 Current Consumption Application Note (Doc# 2174287)
- [9] EM9190 Low Power mmWave RF Customization File Preparation (Doc# 2174286)
- [10] EM9190 High Power mmWave RF Customization File Preparation (Doc# 2174282)
- [11] EM919X-EM7690 Non-mmWave Smart Transmit (Doc# 2174291)
- [12] EM919x/EM7690 PCIe Integration Guide (Doc# 41114276)
- [13] Software Integration and Development Guide for Linux USB Platforms (Doc# 41114212)

#### Sierra Wireless Documents Requiring License Agreement

The following documents are available under license agreement — contact your Sierra Wireless representative:

[14] Software Integration and Development Guide for Linux Platforms (Doc# 41113764)

#### Sierra Wireless Documents Requiring NDA

The following documents are available under NDA — contact your Sierra Wireless representative:

[15] EM9 Carrier Aggregations and EN-DC (Doc# 2174317)

For additional documents that may be used (under NDA) to assist with regulatory and certification submissions, contact your Sierra Wireless representative.

### F.2 Industry/Other Documents

The following referenced document are not provided by Sierra Wireless:

- [16] AT Command Set for User Equipment (UE) (Release 6) (Doc# 3GPP TS 27.007)
- [17] FCC Regulations Part 15 Radio Frequency Devices
- [18] IEC-61000-4-2 level 3 (Electrostatic Discharge Immunity Test)
- [19] Mobile Station (MS) Conformance Specification; Part 4: Subscriber Interface Module (Doc# 3GPP TS 11.10-4)

- [20] PCI Express  $M.2^{TM}$  Specification Revision 3.0, Version 1.2
- [21] Universal Serial Bus Specification, Rev 2.0
- [22] Universal Serial Bus Specification, Rev 3.1
- [23] JESD22-A114-B
- [24] JESD22-C101
- [25] MIPI Alliance Specification for RF Front-End Control Interface

# **G**: Abbreviations

Table G-1: Abbreviations and Definitions

| Abbreviation or Term | Definition   |  |
|----------------------|--|--|
| 3GPP                 | 3rd Generation Partnership Project   |  |
| 8PSK                 | Octagonal Phase Shift Keying   |  |
| AGC                  | Automatic Gain Control   |  |
| A-GPS                | Assisted GPS   |  |
| API                  | Application Programming Interface  |  |
| BeiDou               | BeiDou Navigation Satellite System A Chinese system that uses a series of satellites in geostationary orbit and Medium Earth Orbit (MEO) to provide navigational data.   |  |
| BER                  | Bit Error Rate — A measure of receive sensitivity  |  |
| BLER                 | Block Error Rate   |  |
| Bluetooth            | Wireless protocol for data exchange over short distances   |  |
| CQI                  | Channel Quality Indication   |  |
| СОМ                  | Communication port   |  |
| CPE                  | Customer-Premises Equipment  |  |
| CS                   | Circuit-switched   |  |
| CSG                  | Closed Subscriber Group  |  |
| CW                   | Continuous waveform  |  |
| dB                   | Decibel = 10 x log <sub>10</sub> (P1/P2)<br>P1 is calculated power; P2 is reference power<br>Decibel = 20 x log <sub>10</sub> (V1/V2)<br>V1 is calculated voltage, V2 is reference voltage   |  |
| dBm                  | A logarithmic (base 10) measure of relative power (dB for decibels); relative to milliwatts (m). A dBm value will be 30 units (1000 times) larger (less negative) than a dBW value, because of the difference in scale (milliwatts vs. watts). |  |
| DC-HSPA+             | Dual Carrier HSPA+   |  |
| DCS                  | Digital Cellular System A cellular communication infrastructure that uses the 1.8 GHz radio spectrum.  |  |
| DL                   | Downlink (network to mobile)   |  |
| DRx                  | Diversity Receiver   |  |
| DRX                  | Discontinuous Reception  |  |
| DSM                  | Distributed Shared Memory  |  |
| DUT                  | Device Under Test  |  |

Table G-1: Abbreviations and Definitions (Continued)

| Abbreviation or Term | Definition  |  |
|----------------------|---|--|
| EGNOS                | European Geostationary Navigation Overlay Service (SBAS for GPS, GLONASS, Galileo)  |  |
| elCIC                | Enhanced Inter-Cell Interference Coordination   |  |
| EIRP                 | Effective (or Equivalent) Isotropic Radiated Power  |  |
| EMC                  | Electromagnetic Compatibility   |  |
| EMI                  | Electromagnetic Interference  |  |
| ENDC                 | E-UTRAN New Radio — Dual Connectivity   |  |
| EP                   | End Point   |  |
| ERP                  | Effective Radiated Power  |  |
| ESD                  | Electrostatic Discharge   |  |
|                      | Federal Communications Commission   |  |
| FCC                  | The U.S. federal agency that is responsible for interstate and foreign communications. The FCC regulates commercial and private radio spectrum management, sets rates for communications services, determines standards for equipment, and controls broadcast licensing. Consult www.fcc.gov. |  |
| FDD                  | Frequency Division Duplexing  |  |
| FDMA                 | Frequency Division Multiple Access  |  |
| felCIC               | Further Enhanced Inter-Cell Interference Coordination   |  |
| FER                  | Frame Error Rate — A measure of receive sensitivity.  |  |
| firmware             | Software stored in ROM or EEPROM; essential programs that remain even when the system is turned off. Firmware is easier to change than hardware but more permanent than software stored c disk.   |  |
| FOTA                 | Firmware Over The Air — Technology used to download firmware upgrades directly from the service provider, over the air.   |  |
| FOV                  | Field Of View   |  |
| FPC                  | Flexible Printed Cable  |  |
| FSN                  | Factory Serial Number—A unique serial number assigned to the module during manufacturing.   |  |
| Galileo              | A European system that uses a series of satellites in Medium Earth Orbit (MEO) to provide navigational data.  |  |
| GCF                  | Global Certification Forum  |  |
| GLONASS              | Global Navigation Satellite System — A Russian system that uses a series of 24+ satellites in Medium Earth Orbit (MEO) to provide navigational data.  |  |
| GMSK                 | Gaussian Minimum Shift Keying modulation  |  |
| GNSS                 | Global Navigation Satellite Systems (GPS, GLONASS, BeiDou, and Galileo)   |  |
| GPS                  | Global Positioning System An American system that uses a series of 24–32 satellites in Medium Earth Orbit (MEO) to provide navigational data.   |  |

Table G-1: Abbreviations and Definitions (Continued)

| Abbreviation or Term | Definition   |
|----------------------|--|
| НВ                   | High Band  |
| Host                 | The device into which an embedded module is integrated   |
| HSDPA                | High Speed Downlink Packet Access  |
| HSPA+                | Enhanced HSPA, as defined in 3GPP Release 7 and beyond   |
| HSUPA                | High Speed Uplink Packet Access  |
| Hz                   | Hertz = 1 cycle/second   |
| IC                   | Industry Canada  |
| IF                   | Intermediate Frequency   |
| IMEI                 | International Mobile Equipment Identity  |
| IMS                  | IP Multimedia Subsystem — Architectural framework for delivering IP multimedia services.   |
| inrush current       | Peak current drawn when a device is connected or powered on  |
| inter-RAT            | Radio Access Technology  |
| IOT                  | Interoperability Testing   |
| IS                   | Interim Standard. After receiving industry consensus, the TIA forwards the standard to ANSI for approval.  |
| ISIM                 | IMS Subscriber Identity Module (Also referred to as a SIM card)  |
| LAA                  | Licensed Assisted Access   |
| LB                   | Low Band   |
| LED                  | Light Emitting Diode. A semiconductor diode that emits visible or infrared light.  |
| LHCP                 | Left-Hand Circular Polarized   |
| LNA                  | Low Noise Amplifier  |
| LPM                  | Low Power Mode   |
| LPT                  | Line Print Terminal  |
| LTE                  | Long Term Evolution—a high-performance air interface for cellular mobile communication systems.  |
| MB                   | Mid Band   |
| MCS                  | Modulation and Coding Scheme   |
| MEO                  | Medium Earth Orbit   |
| MHz                  | Megahertz = 10e6 Hz  |
| MIMO                 | Multiple Input Multiple Output—wireless antenna technology that uses multiple antennas at both transmitter and receiver side. This improves performance. |
| MPR                  | Maximum Power Reduction  |

Table G-1: Abbreviations and Definitions (Continued)

| Abbreviation or Term | Definition   |
|----------------------|--|
| MSAS                 | Multi-functional Satellite Augmentation System (SBAS for GPS)  |
| NAS/AS               | Network Access Server  |
| NC                   | No Connect   |
| NIC                  | Network Interface Card   |
| NLIC                 | Non-Linear Interference Cancellation   |
| NMEA                 | National Marine Electronics Association  |
| NSA                  | 5G Non-standalone architecture   |
| ODM                  | Original Design Manufacturer   |
| OEM                  | Original Equipment Manufacturer—a company that manufactures a product and sells it to a reseller.                                    |
| OFDMA                | Orthogonal Frequency Division Multiple Access  |
| OMA DM               | Open Mobile Alliance Device Management — A device management protocol.   |
| ОТА                  | 'Over the air' (or radiated through the antenna)   |
| РА                   | Power Amplifier  |
| packet               | A short, fixed-length block of data, including a header, that is transmitted as a unit in a communications network.                  |
| PCB                  | Printed Circuit Board  |
| PCC                  | Primary Component Carrier  |
| PCS                  | Personal Communication System A cellular communication infrastructure that uses the 1.9 GHz radio spectrum.                          |
| PDN                  | Packet Data Network  |
| PMI                  | Pre-coding Matrix Index  |
| PRx                  | Primary Receiver   |
| PSS                  | Primary synchronization signal   |
| PST                  | Product Support Tools  |
| PTCRB                | PCS Type Certification Review Board  |
| QAM                  | Quadrature Amplitude Modulation.  This form of modulation uses amplitude, frequency, and phase to transfer data on the carrier wave. |
| QCI                  | QoS Class Identifier   |
| QMI                  | Qualcomm MSM/Modem Interface   |
| QOS                  | Quality of Service   |
| QPSK                 | Quadrature Phase-Shift Keying  |
| QPST                 | Qualcomm Product Support Tools   |

Table G-1: Abbreviations and Definitions (Continued)

| Abbreviation or Term | Definition  |
|----------------------|---|
| QZSS                 | Quasi-Zenith Satellite System — Japanese system for satellite-based augmentation of GPS.  |
| RAT                  | Radio Access Technology   |
| RC                   | Root Complex  |
| RF                   | Radio Frequency   |
| RI                   | Ring Indicator  |
| roaming              | A cellular subscriber is in an area where service is obtained from a cellular service provider that is not the subscriber's provider.   |
| RSE                  | Radiated Spurious Emissions   |
| RSSI                 | Received Signal Strength Indication   |
| SA                   | 5G Standalone architecture  |
| SAR                  | Specific Absorption Rate  |
| SBAS                 | Satellite-based Augmentation System   |
| SCC                  | Secondary Component Carrier   |
| SCS                  | Subcarrier Spacing  |
| SDK                  | Software Development Kit  |
| SED                  | Smart Error Detection   |
| Sensitivity (Audio)  | Measure of lowest power signal that the receiver can measure.   |
| Sensitivity (RF)     | Measure of lowest power signal at the receiver input that can provide a prescribed BER/BLER/SNR value at the receiver output.   |
| SG                   | An LTE signaling interface for SMS ("SMS over SGs")   |
| SIB                  | System Information Block  |
| SIM                  | Subscriber Identity Module. Also referred to as USIM or UICC.   |
| SIMO                 | Single Input Multiple Output—smart antenna technology that uses a single antenna at the transmitter side and multiple antennas at the receiver side. This improves performance and security.                            |
| SISO                 | Single Input Single Output—antenna technology that uses a single antenna at both the transmitter side and the receiver side.  |
| SKU                  | Stock Keeping Unit—identifies an inventory item: a unique code, consisting of numbers or letters and numbers, assigned to a product by a retailer for purposes of identification and inventory control.                 |
| SMS                  | Short Message Service.  A feature that allows users of a wireless device on a wireless network to receive or transmit short electronic alphanumeric messages (up to 160 characters, depending on the service provider). |
| S/N                  | Signal-to-noise (ratio)   |
| SNR                  | Signal-to-Noise Ratio   |
| SOF                  | Start of Frame — A USB function.  |

Table G-1: Abbreviations and Definitions (Continued)

| Abbreviation or Term | Definition   |
|----------------------|--|
| SSS                  | Secondary synchronization signal.  |
| SUPL                 | Secure User Plane Location   |
| TDD                  | Time Division Duplexing  |
| TD-SCDMA             | Time Division Synchronous Code Division Multiple Access  |
| TIA/EIA              | Telecommunications Industry Association / Electronics Industry Association. A standards setting trade organization, whose members provide communications and information technology products, systems, distribution services and professional services in the United States and around the world. Consult www.tiaonline.org. |
| TIS                  | Total Isotropic Sensitivity  |
| TRP                  | Total Radiated Power   |
| TRx                  | Transceiver<br>Transmits and receives signals  |
| UDK                  | Universal Development Kit (for PCI Express Mini Cards)   |
| UE                   | User Equipment   |
| UHB                  | Ultra-High Band  |
| UICC                 | Universal Integrated Circuit Card (Also referred to as a SIM card.)  |
| UL                   | Uplink (mobile to network)   |
| UMTS                 | Universal Mobile Telecommunications System   |
| USB                  | Universal Serial Bus   |
| USIM                 | Universal Subscriber Identity Module (UMTS)  |
| VCC                  | Supply voltage   |
| VDC                  | Volts DC   |
| VSWR                 | Voltage Standing Wave Ratio  |
| WAN                  | Wide Area Network  |
| WCDMA                | Wideband Code Division Multiple Access (also referred to as UMTS)  |
| WLAN                 | Wireless Local Area Network  |
| WAAS                 | Wide Area Augmentation System (SBAS for GPS)   |
| ZIF                  | Zero Intermediate Frequency  |
| ZUC                  | ZUC stream cypher  |